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10	Alviso (VSS,NCTF) 5/5	0.2	050523	35	CPU_Vcore	0.2	050523
11	VGA(nVIDIA NV44M) 1/5	0.2	050523	36	VGA 1.25/1.2V	0.2	050523
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14	VGA(nVIDIA NV44M) 4/5	0.2	050523	39	other power plan	0.2	050523
15	VGA(nVIDIA NV44M) 5/5	0.2	050523	40	OVP protection	0.2	050523
16	NV44M(DDR F_A B_1)	0.2	050523	41	History(1)	0.2	050523
17	DDR(II)SO-DIMM	0.2	050523	42	History(2)	0.2	050523
18	DDR(II)Termination	0.2	050523	43	Revision History	0.2	050523
19	ICH6-M( CPU,PCI,IDE )	0.2	050523				
20	ICH6-M( USB,HUB,LPC )	0.2	050523				
21	ICH6-M( POWER&GND )	0.2	050523				
22	IDE (HDD&CD_ROM)	0.2	050523				
23	USB2.0/OIDE/FAN/DOCKING	0.2	050523				
24	PCI7420B(PCMCIA)	0.2	050523				
25	PCI7420B(iLink,MS)/MDC	0.2	050523				

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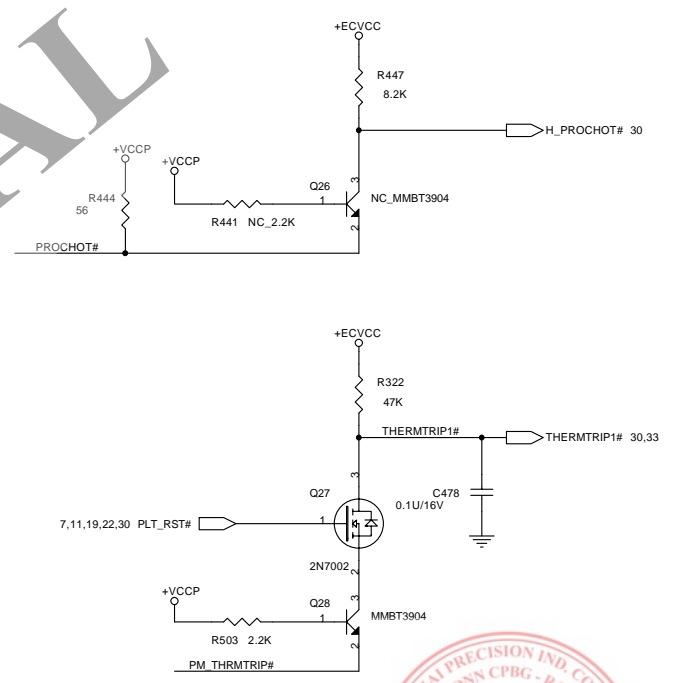
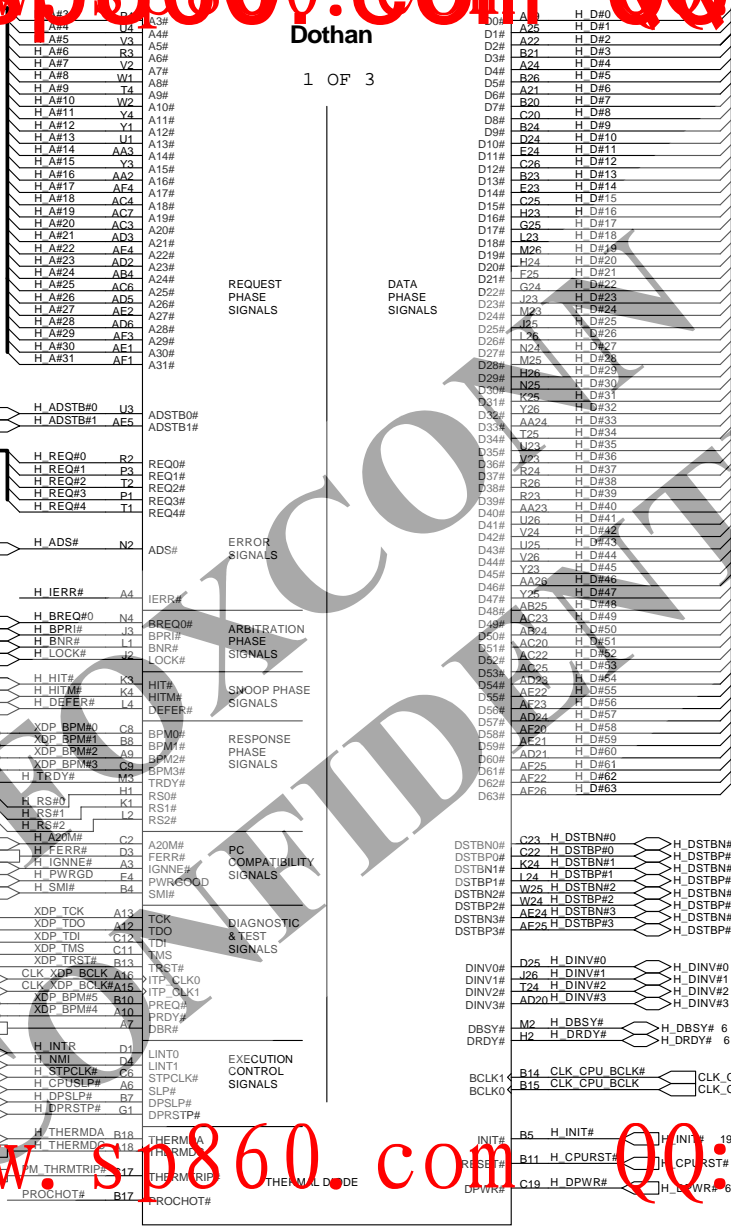
Project Leader	Appr. by	Check by	Design by
			Alex

Project Code & Schematics Subject:	MS03 M/B-FUBAI	PCB P/N:	1P-0055100-80SB
Project Code & Schematics Subject:	MS03 M/B-HANNSTAR	PCB P/N:	1P-0055500-80SB
Project Code & Schematics Subject:	MS03 M/B-NAN YA	PCB P/N:	1P-0055200-80SB

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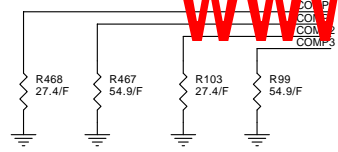
Dothan  
1 OF 3



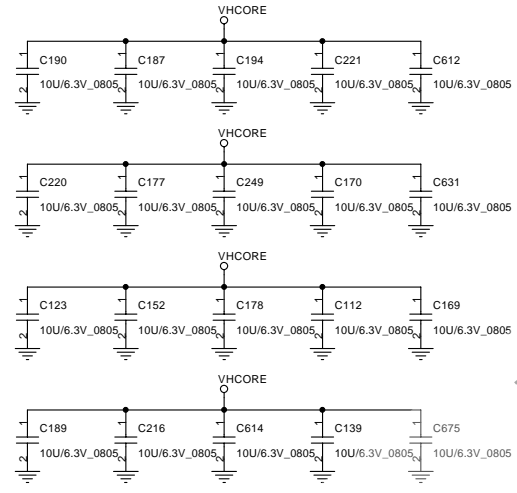
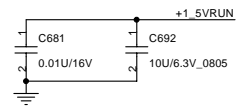
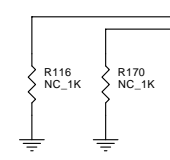
Place near CPU.

PM\_THRMTRIP# should connect to ICH6-M and ALVISO without T-ing (No stub)

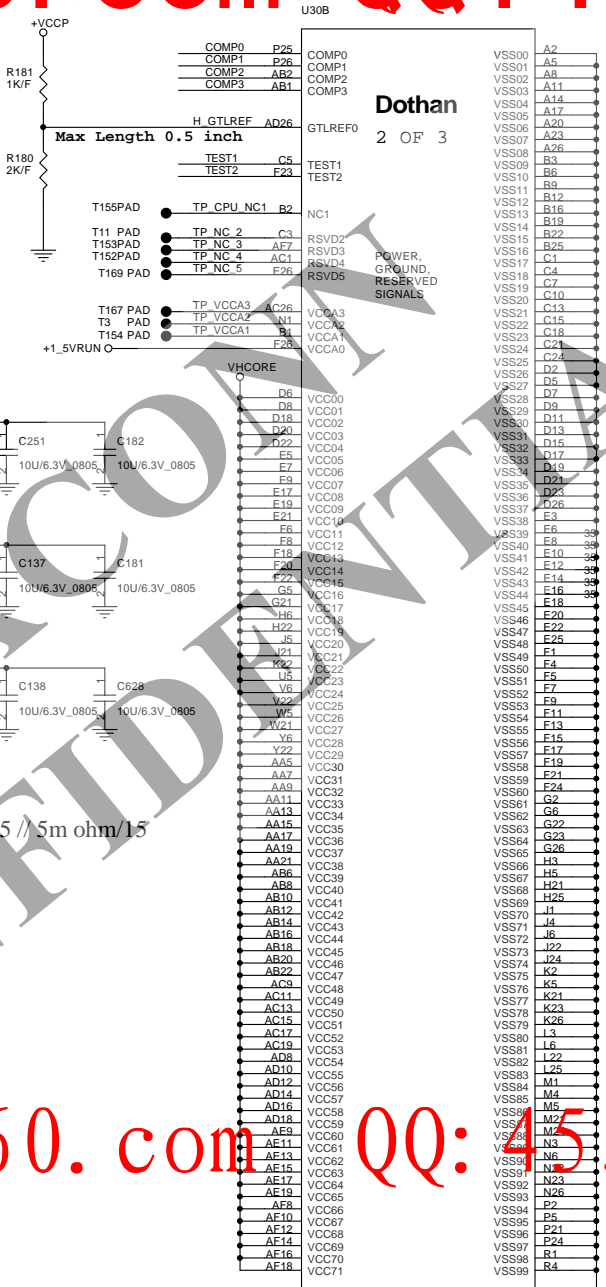
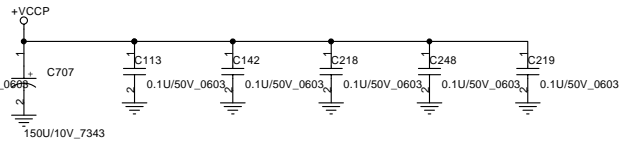
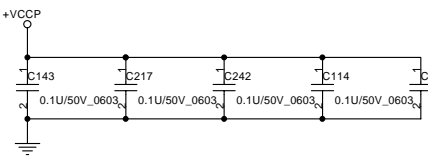




Place pulldown resistors within 0.5" of COMP pins



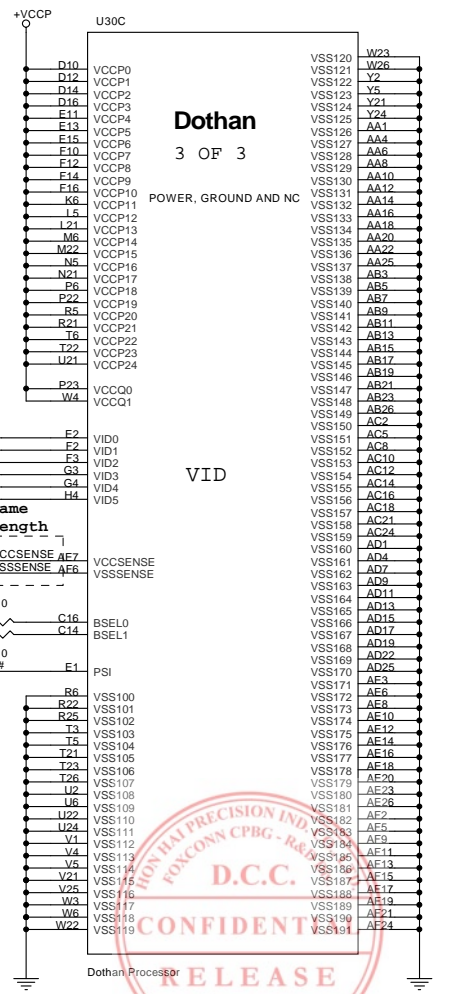
Total caps = 2633 uF  
ESR = 15m ohm/5 // 5m ohm/25 // 5m ohm/15



Dothan 2 OF 3

POWER, GROUND, RESERVED SIGNALS

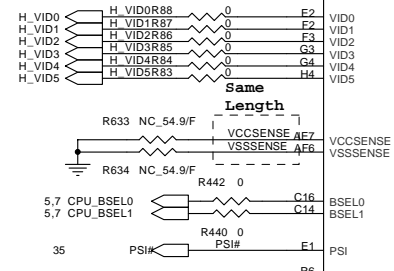
Dothan Processor



Dothan 3 OF 3

POWER, GROUND AND NC

VID



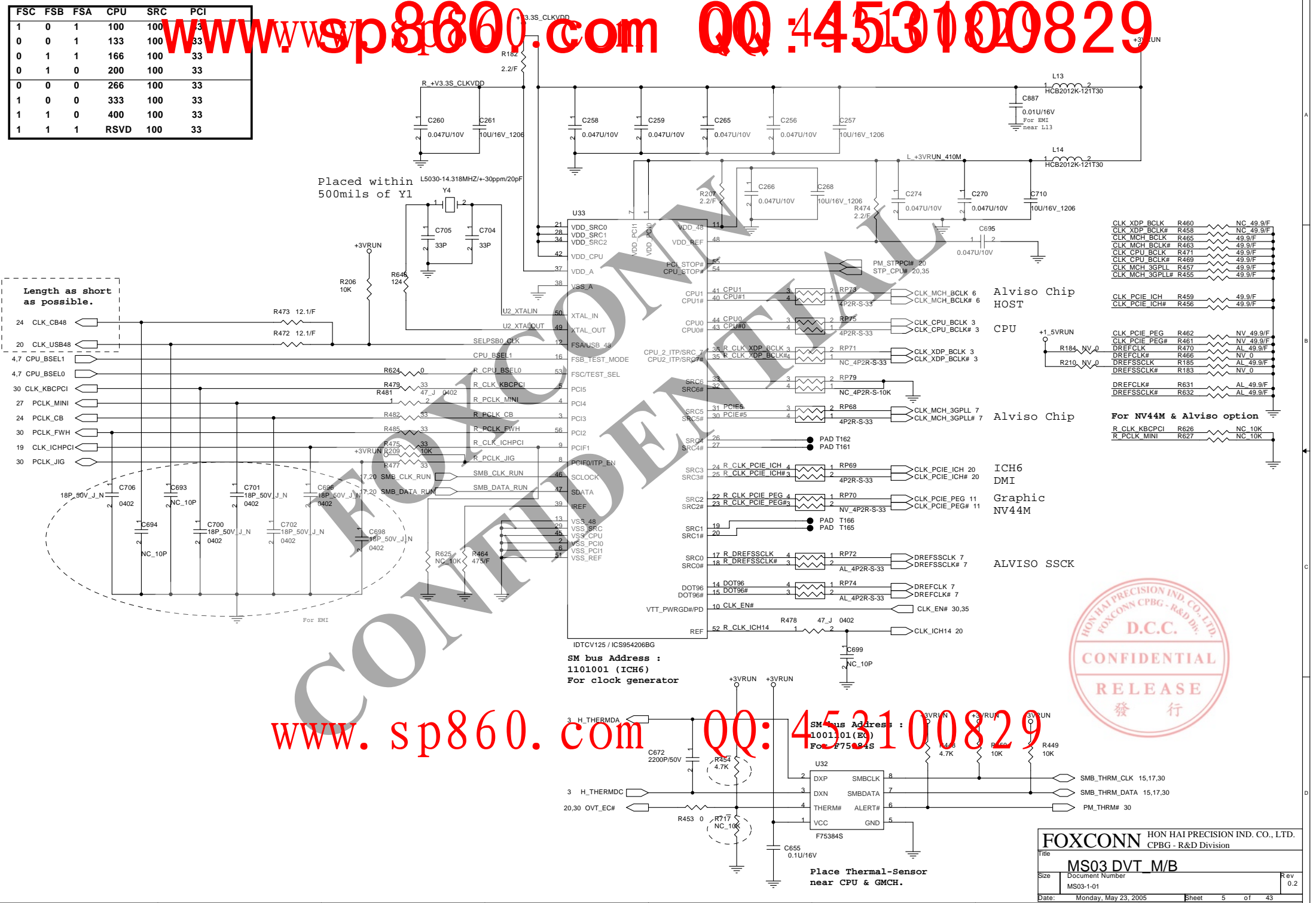
Same Length





FSC	FSB	FSA	CPU	SRC	PCI
1	0	1	100	100	33
0	0	1	133	100	33
0	1	1	166	100	33
0	1	0	200	100	33
0	0	0	266	100	33
1	0	0	333	100	33
1	1	0	400	100	33
1	1	1	RSVD	100	33

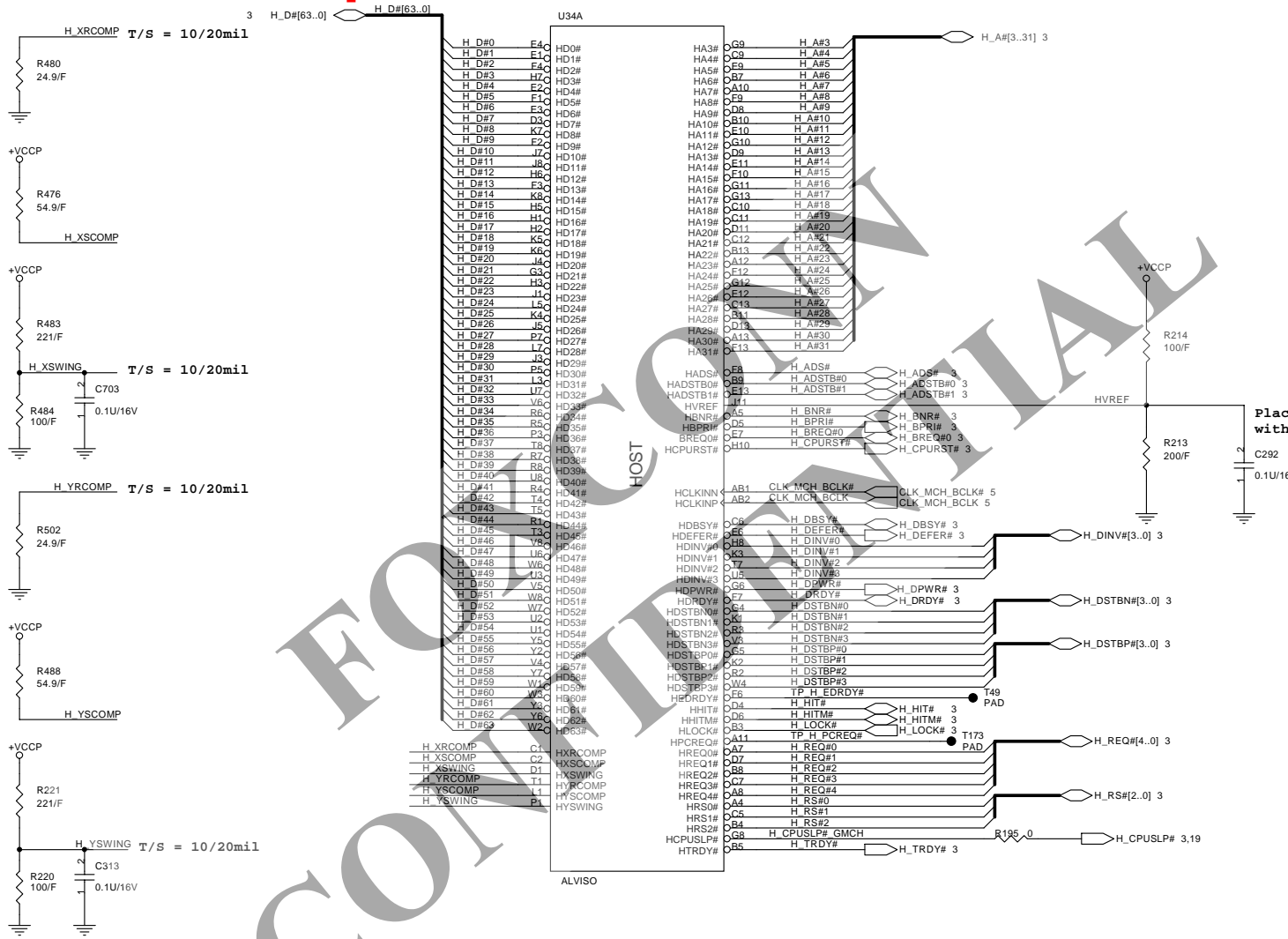
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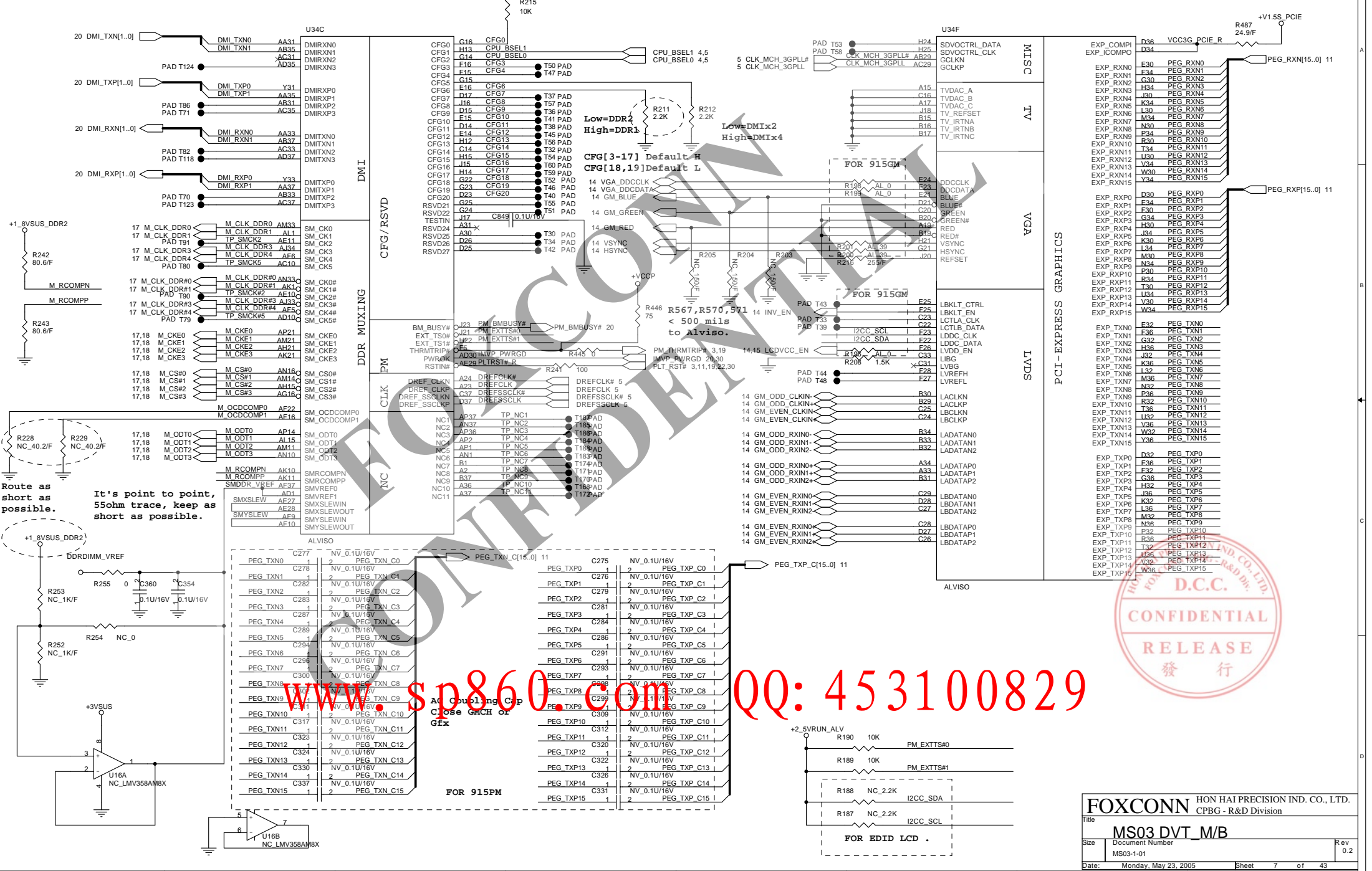
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Place Cap. near GMCH within 100 mils.

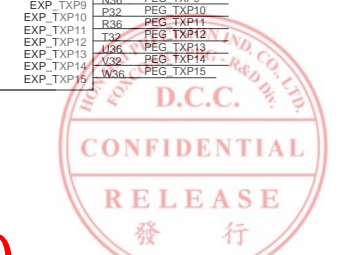


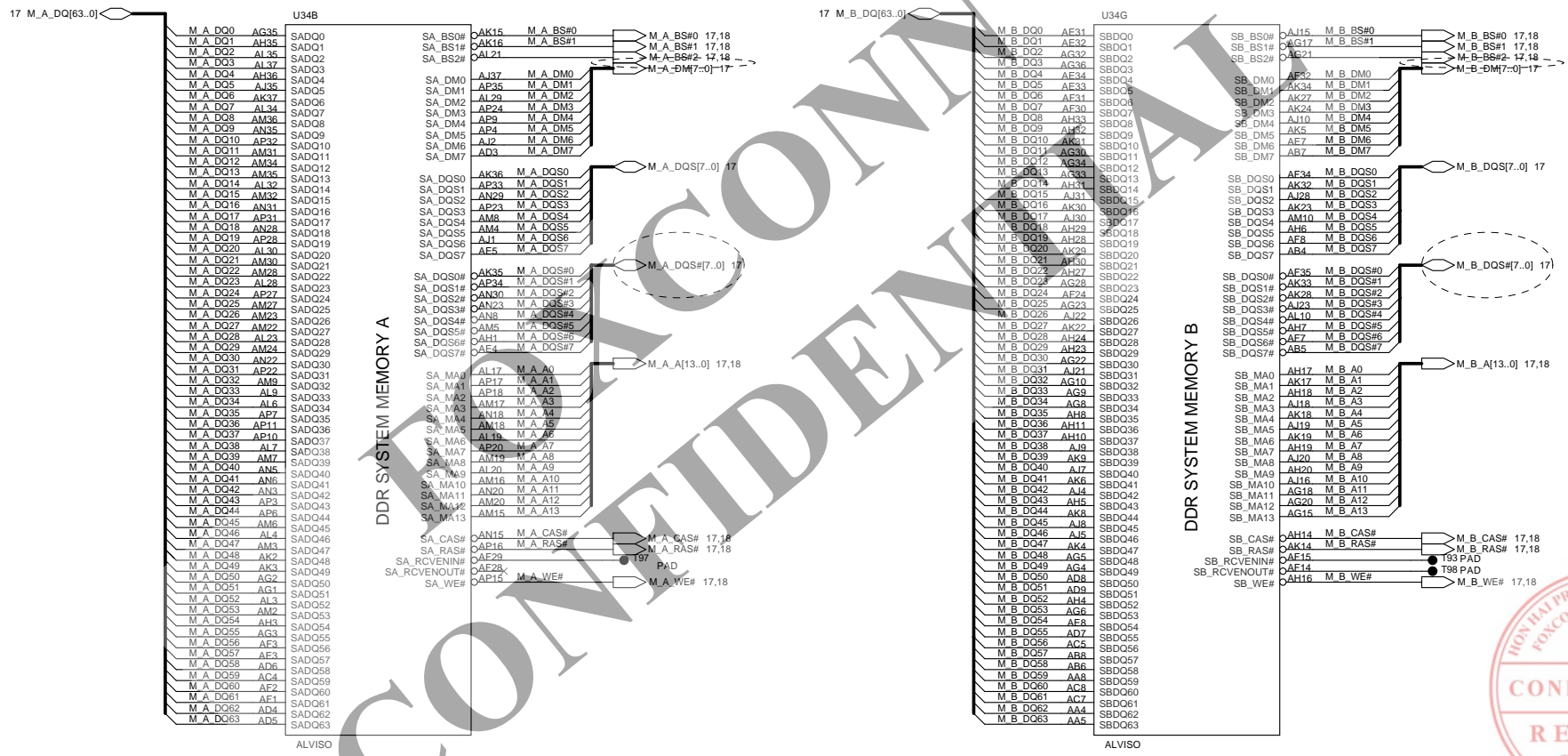
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Route as short as possible.  
It's point to point, 55ohm trace, keep as short as possible.

ALVISO	PEG_TXN0	PEG_TXN1	PEG_TXN2	PEG_TXN3	PEG_TXN4	PEG_TXN5	PEG_TXN6	PEG_TXN7	PEG_TXN8	PEG_TXN9	PEG_TXN10	PEG_TXN11	PEG_TXN12	PEG_TXN13	PEG_TXN14	PEG_TXN15
C277	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C278	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C282	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C283	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C287	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C289	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C294	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C295	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C300	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C301	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C309	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C317	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C323	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C324	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C330	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1
C337	1	2	1	1	1	1	1	1	1	1	1	1	1	1	1	1



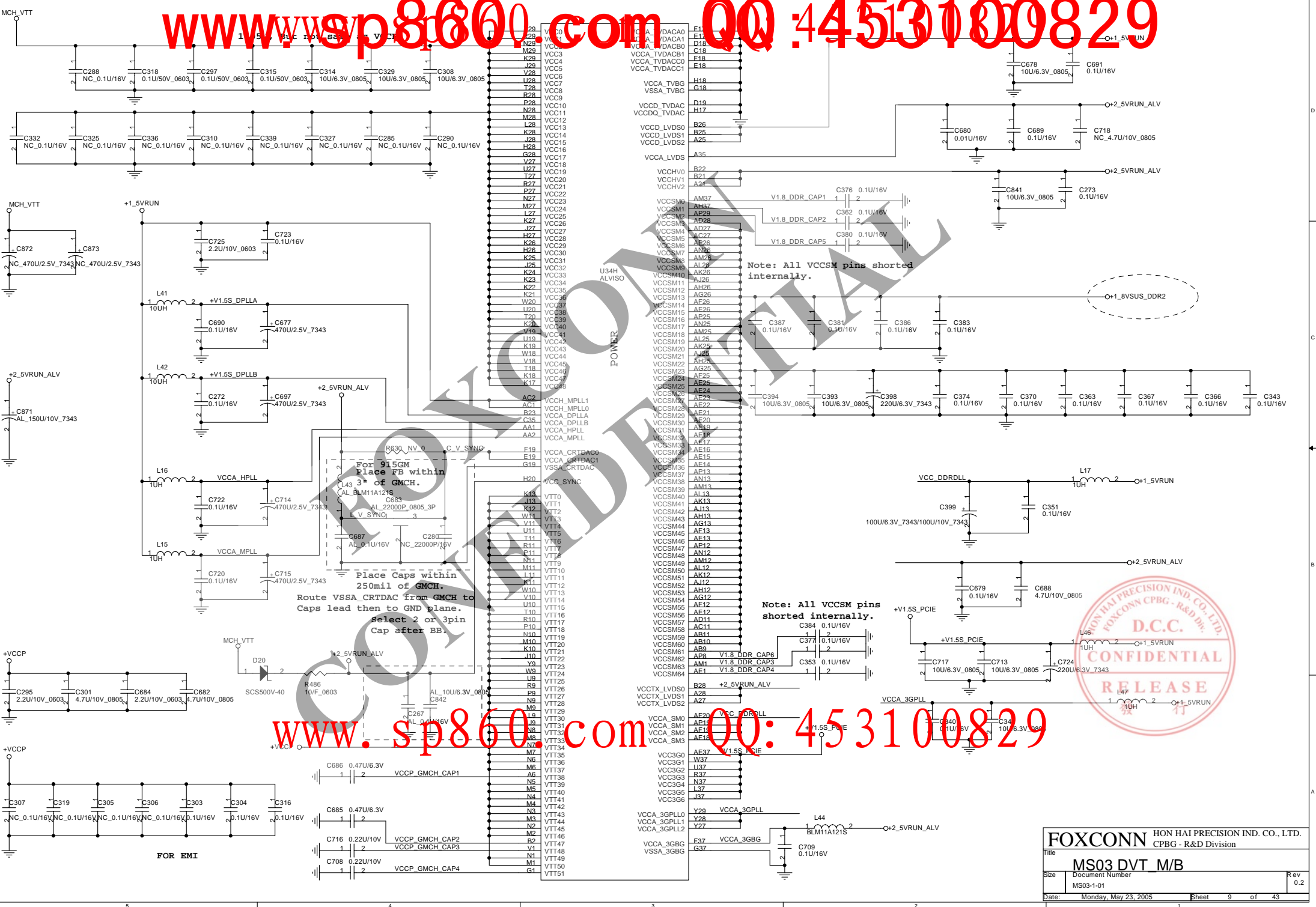


DDR SYSTEM MEMORY A

DDR SYSTEM MEMORY B







VCC0	VCC1	VCC2	VCC3	VCC4	VCC5	VCC6	VCC7	VCC8	VCC9	VCC10	VCC11	VCC12	VCC13	VCC14	VCC15	VCC16	VCC17	VCC18	VCC19	VCC20	VCC21	VCC22	VCC23	VCC24	VCC25	VCC26	VCC27	VCC28	VCC29	VCC30	VCC31	VCC32	VCC33	VCC34	VCC35	VCC36	VCC37	VCC38	VCC39	VCC40	VCC41	VCC42	VCC43	VCC44	VCC45	VCC46	VCC47	VCC48	VCC49	VCC50	VCC51	VCC52	VCC53	VCC54	VCC55	VCC56	VCC57	VCC58	VCC59	VCC60	VCC61	VCC62	VCC63	VCC64	VCC65	VCC66	VCC67	VCC68	VCC69	VCC70	VCC71	VCC72	VCC73	VCC74	VCC75	VCC76	VCC77	VCC78	VCC79	VCC80	VCC81	VCC82	VCC83	VCC84	VCC85	VCC86	VCC87	VCC88	VCC89	VCC90	VCC91	VCC92	VCC93	VCC94	VCC95	VCC96	VCC97	VCC98	VCC99	VCC100
------	------	------	------	------	------	------	------	------	------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	-------	--------

Note: All VCCSM pins shorted internally.

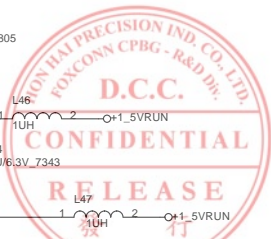
Note: All VCCSM pins shorted internally.

For 915GM Place FB within 3" of GMCH.

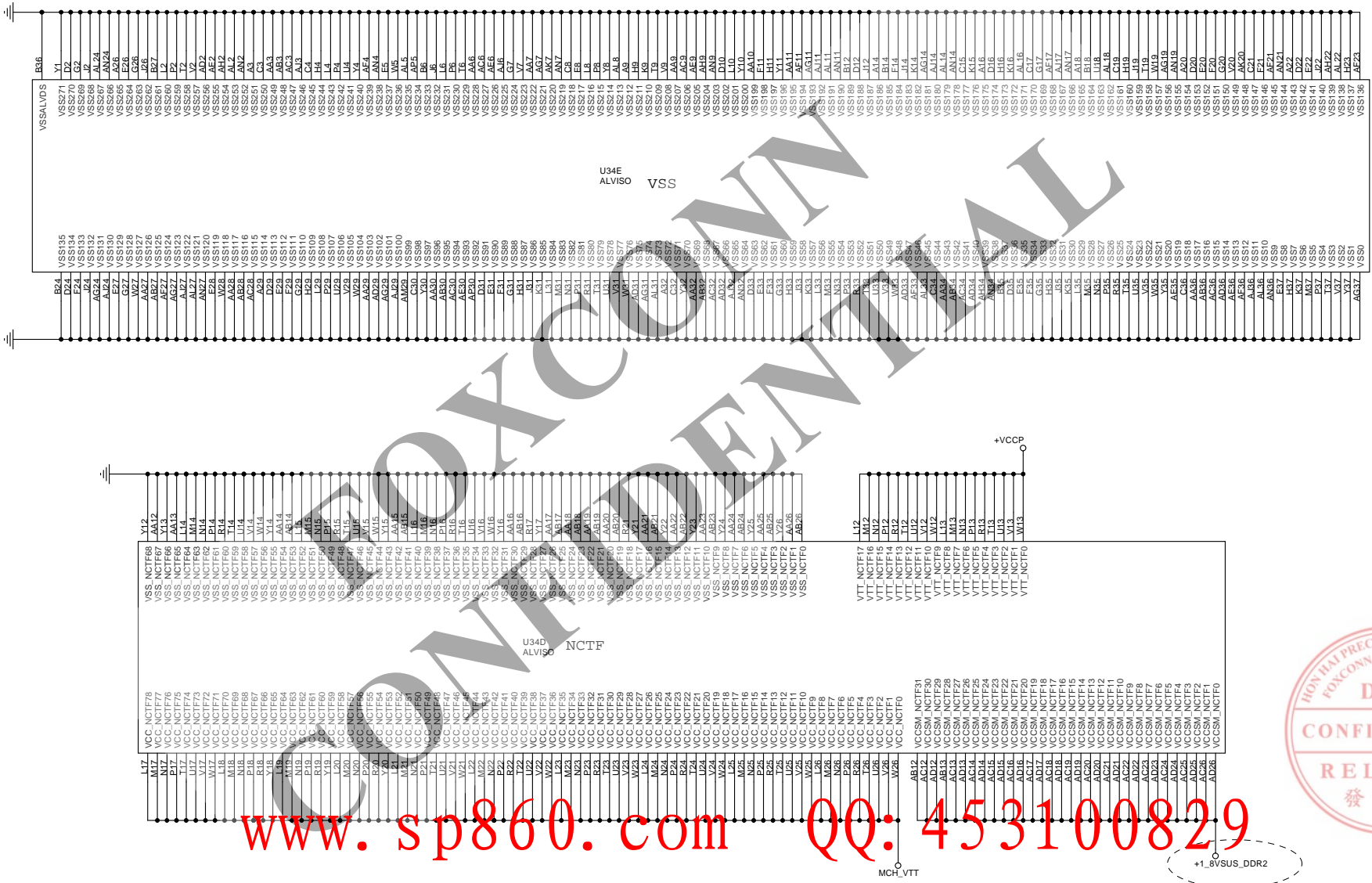
Place Caps within 250mil of GMCH.

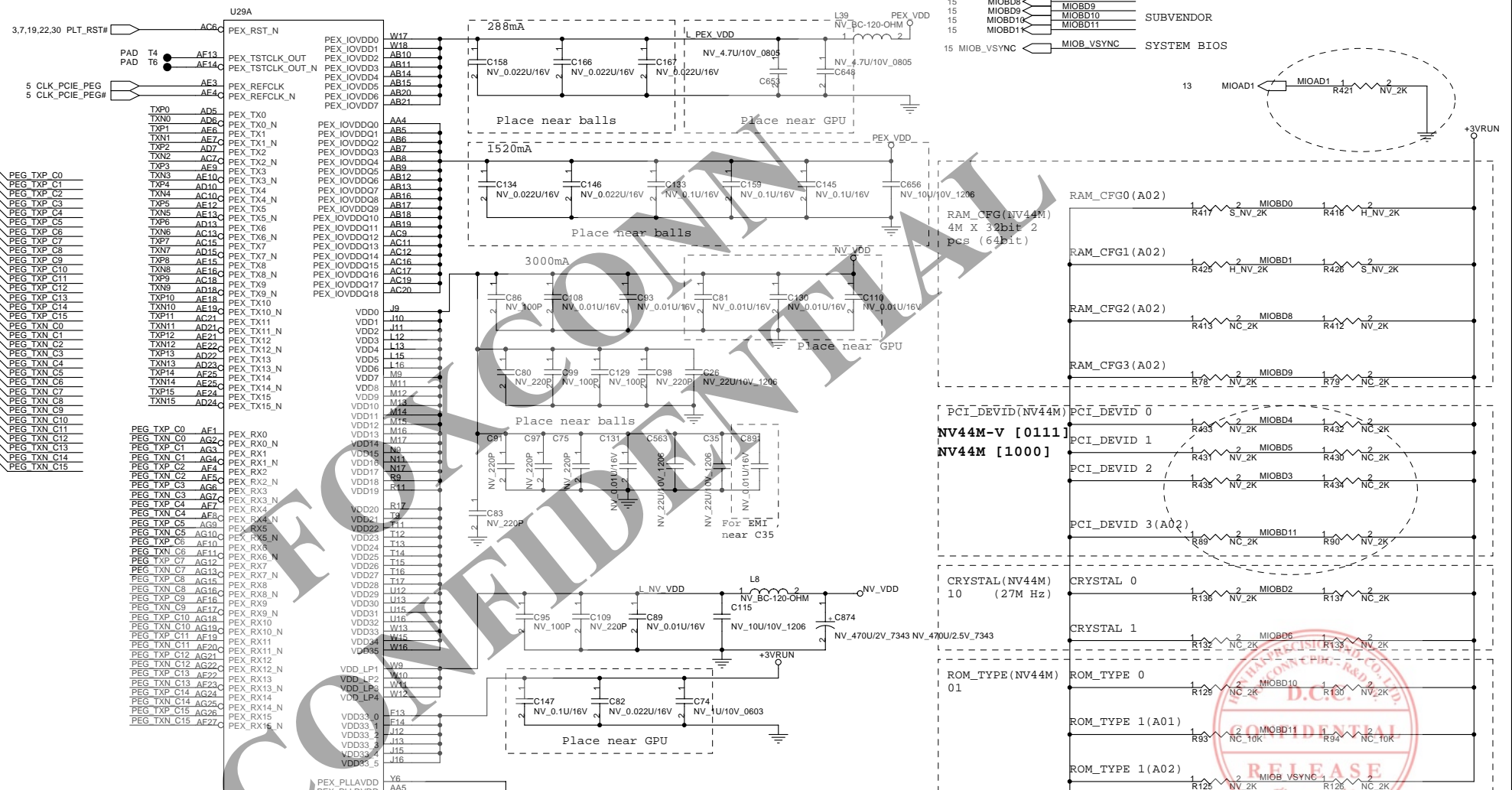
Route VSSA CRTDAC from GMCH to Caps lead then to GND plane.

Select 2 or 3pin Cap after BB.



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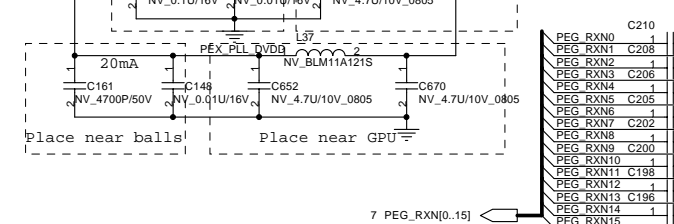
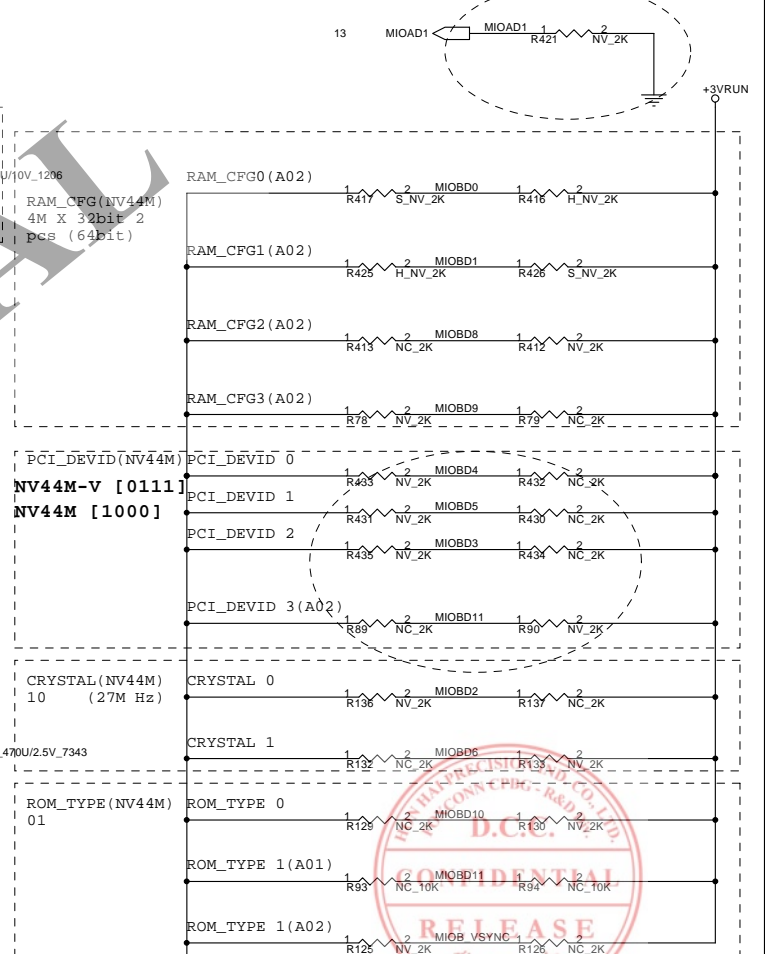


3,7,19,22,30	PLT_RST#	AC6	PEX_RST_N
PAD T4	T6	AF13	PEX_TSTCLK_OUT
		AE14	PEX_TSTCLK_OUT_N
5 CLK_PCIE_PEG		AE3	PEX_REFCLK
5 CLK_PCIE_PEG#		AE4	PEX_REFCLK_N
			PEX_TX0
			PEX_TX0_N
			PEX_TX1
			PEX_TX1_N
			PEX_TX2
			PEX_TX2_N
			PEX_TX3
			PEX_TX3_N
			PEX_TX4
			PEX_TX4_N
			PEX_TX5
			PEX_TX5_N
			PEX_TX6
			PEX_TX6_N
			PEX_TX7
			PEX_TX7_N
			PEX_TX8
			PEX_TX8_N
			PEX_TX9
			PEX_TX9_N
			PEX_TX10
			PEX_TX10_N
			PEX_TX11
			PEX_TX11_N
			PEX_TX12
			PEX_TX12_N
			PEX_TX13
			PEX_TX13_N
			PEX_TX14
			PEX_TX14_N
			PEX_TX15
			PEX_TX15_N

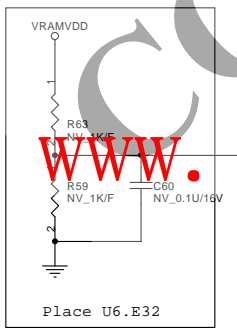
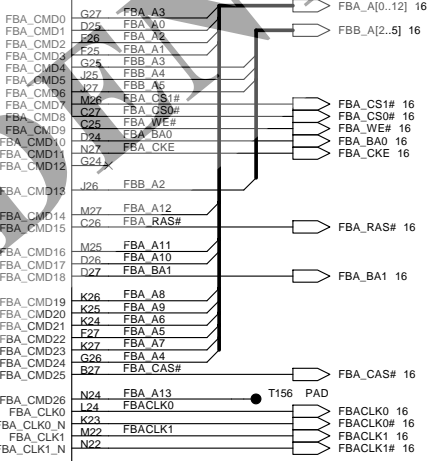
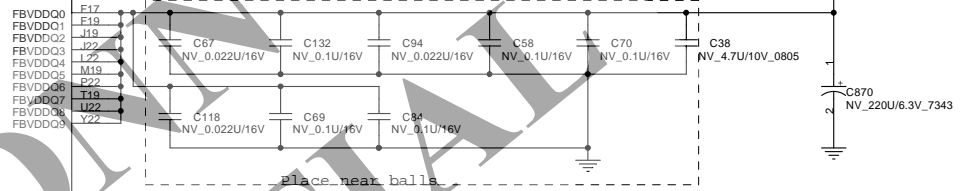
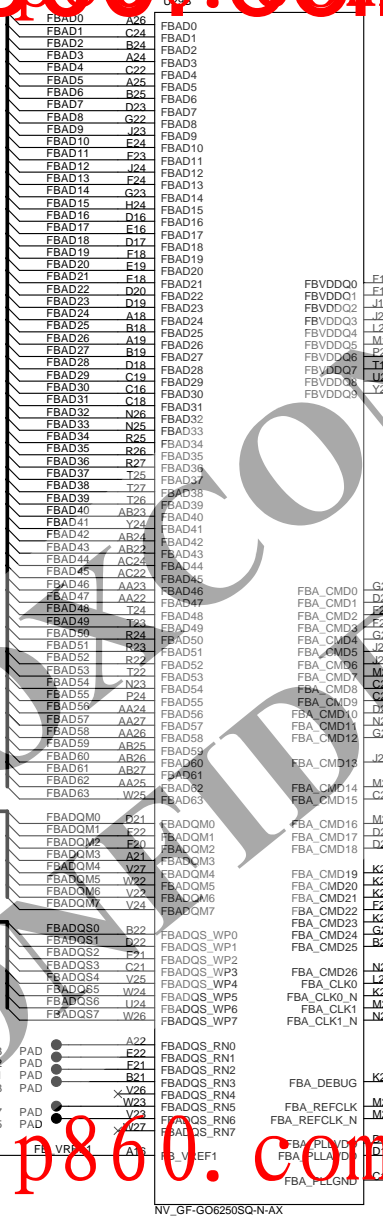
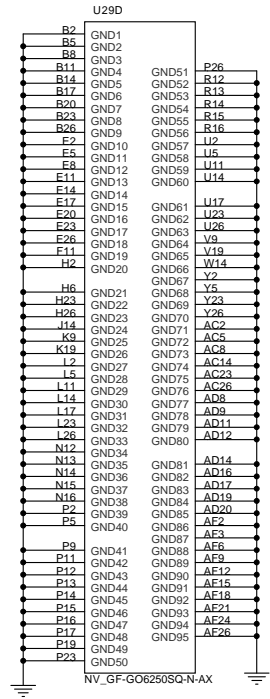
7 PEG_TXP_C0[0..15]			
7 PEG_TXP_C1			
7 PEG_TXP_C2			
7 PEG_TXP_C3			
7 PEG_TXP_C4			
7 PEG_TXP_C5			
7 PEG_TXP_C6			
7 PEG_TXP_C7			
7 PEG_TXP_C8			
7 PEG_TXP_C9			
7 PEG_TXP_C10			
7 PEG_TXP_C11			
7 PEG_TXP_C12			
7 PEG_TXP_C13			
7 PEG_TXP_C14			
7 PEG_TXP_C15			
7 PEG_TXN_C0			
7 PEG_TXN_C1			
7 PEG_TXN_C2			
7 PEG_TXN_C3			
7 PEG_TXN_C4			
7 PEG_TXN_C5			
7 PEG_TXN_C6			
7 PEG_TXN_C7			
7 PEG_TXN_C8			
7 PEG_TXN_C9			
7 PEG_TXN_C10			
7 PEG_TXN_C11			
7 PEG_TXN_C12			
7 PEG_TXN_C13			
7 PEG_TXN_C14			
7 PEG_TXN_C15			

7 PEG_RXP0[0..15]			
7 PEG_RXP1			
7 PEG_RXP2			
7 PEG_RXP3			
7 PEG_RXP4			
7 PEG_RXP5			
7 PEG_RXP6			
7 PEG_RXP7			
7 PEG_RXP8			
7 PEG_RXP9			
7 PEG_RXP10			
7 PEG_RXP11			
7 PEG_RXP12			
7 PEG_RXP13			
7 PEG_RXP14			
7 PEG_RXP15			

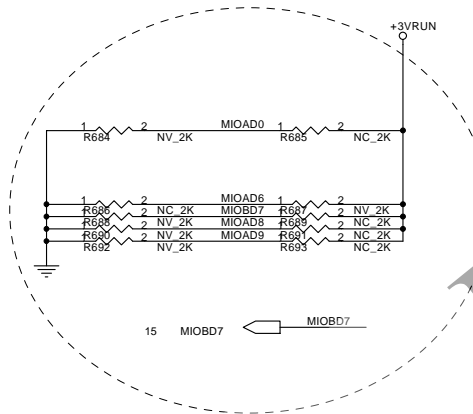
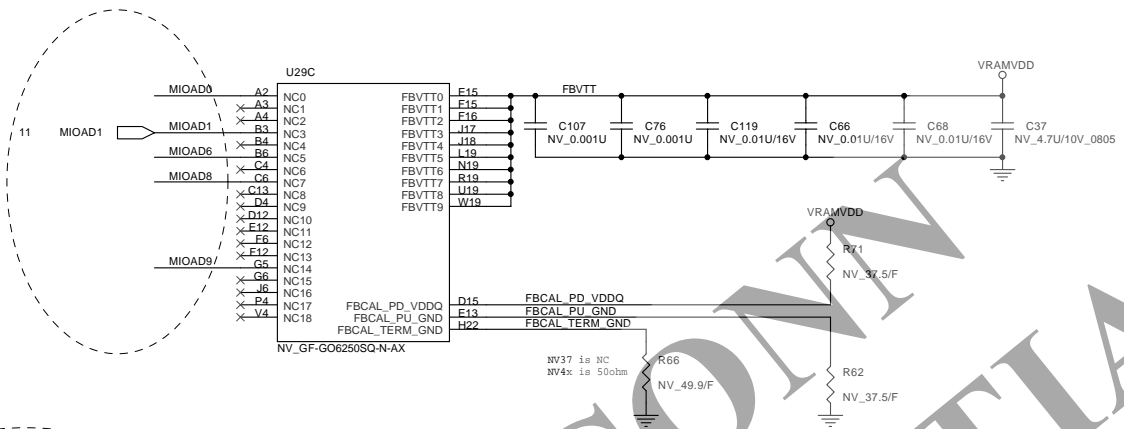
15	MIOD0	MIOD0
15	MIOD1	MIOD1
15	MIOD2	MIOD2
15	MIOD3	MIOD3
15	MIOD4	MIOD4
15	MIOD5	MIOD5
15	MIOD6	MIOD6
15	MIOD7	MIOD7
15	MIOD8	MIOD8
15	MIOD9	MIOD9
15	MIOD10	MIOD10
15	MIOD11	MIOD11
15	MIOD_VSYNC	MIOD_VSYNC



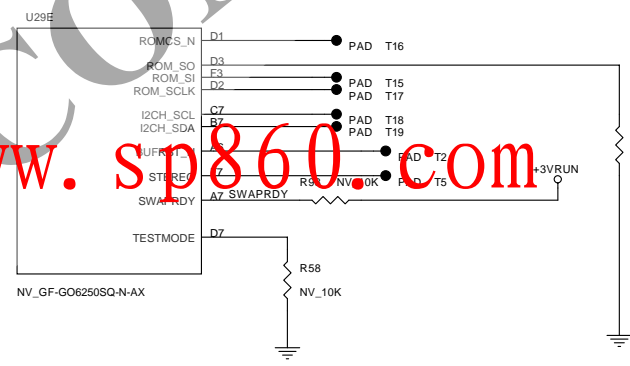
7 PEG_RXN0[0..15]			
7 PEG_RXN1			
7 PEG_RXN2			
7 PEG_RXN3			
7 PEG_RXN4			
7 PEG_RXN5			
7 PEG_RXN6			
7 PEG_RXN7			
7 PEG_RXN8			
7 PEG_RXN9			
7 PEG_RXN10			
7 PEG_RXN11			
7 PEG_RXN12			
7 PEG_RXN13			
7 PEG_RXN14			
7 PEG_RXN15			







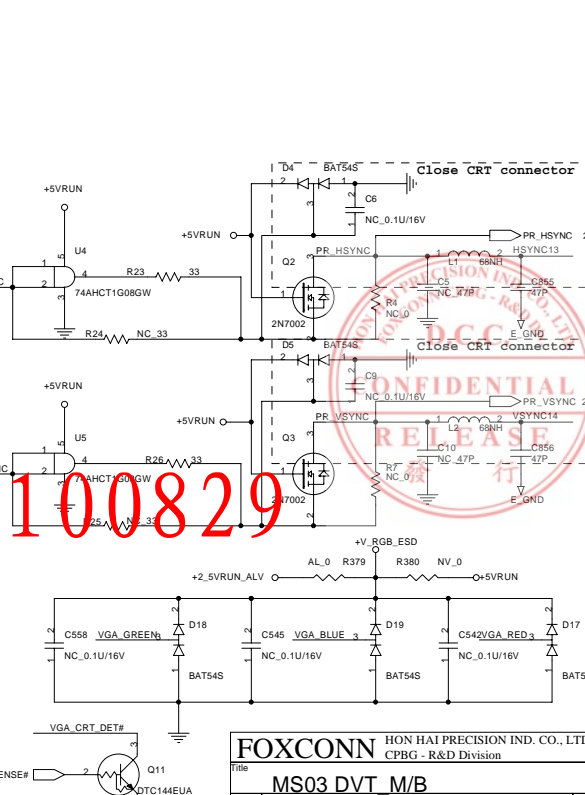
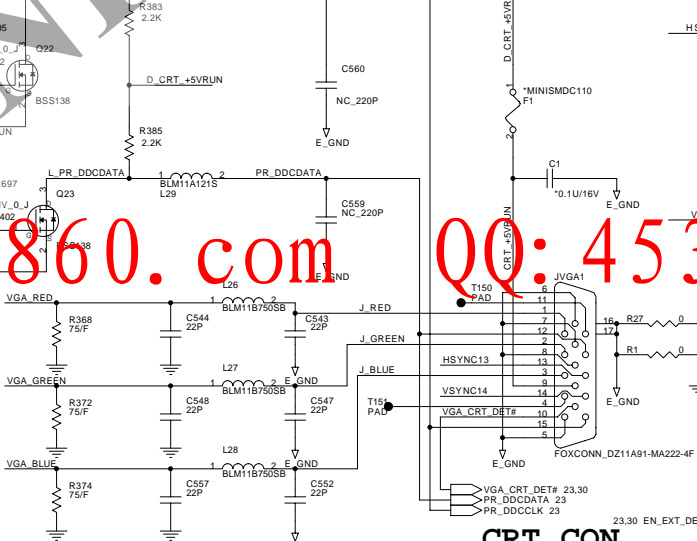
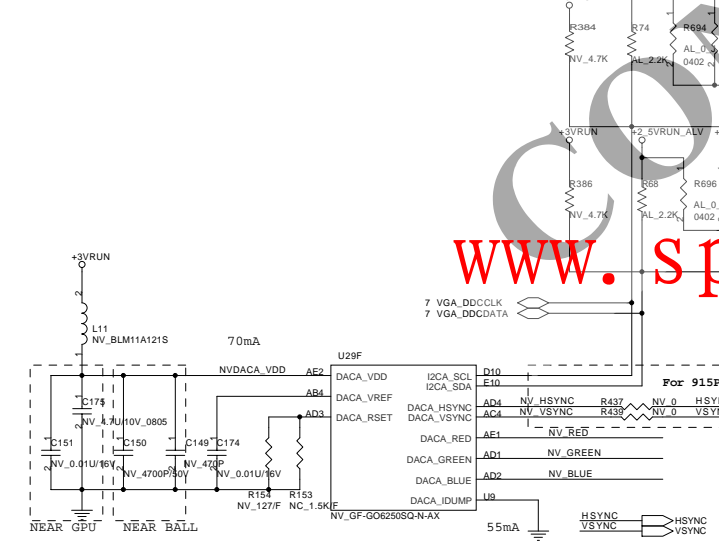
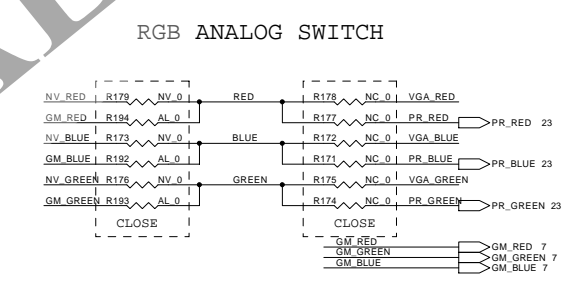
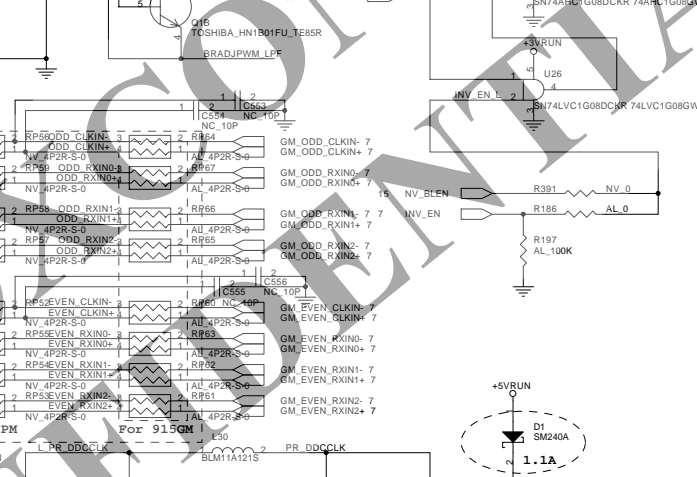
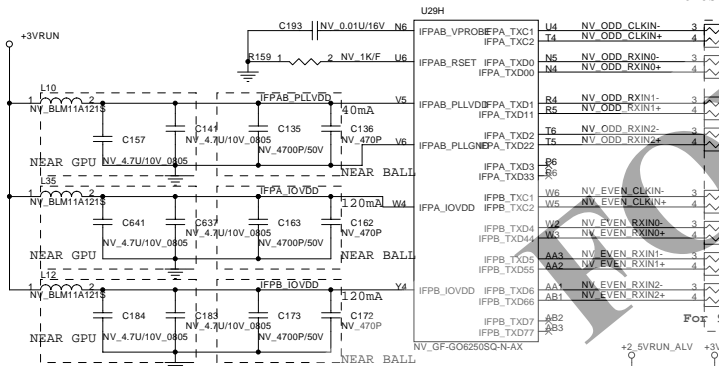
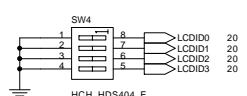
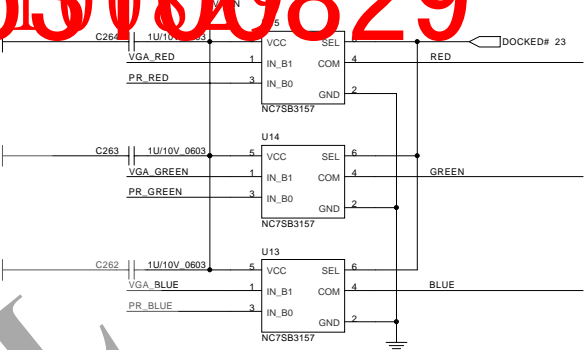
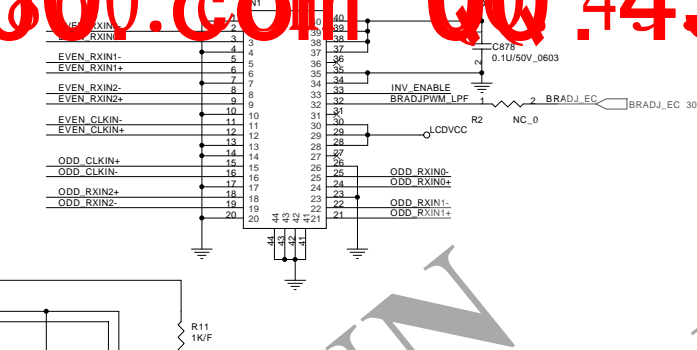
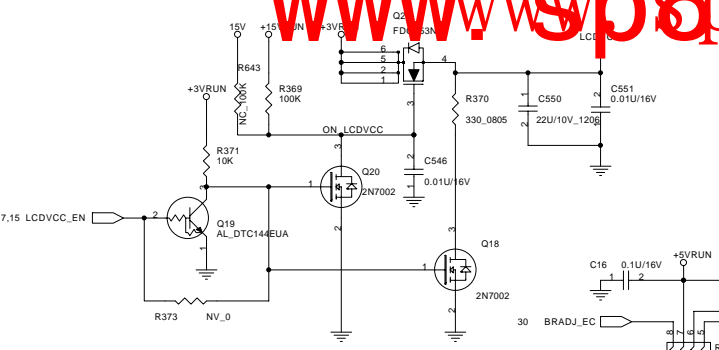
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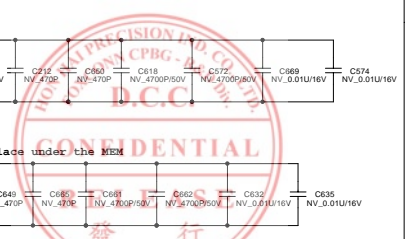
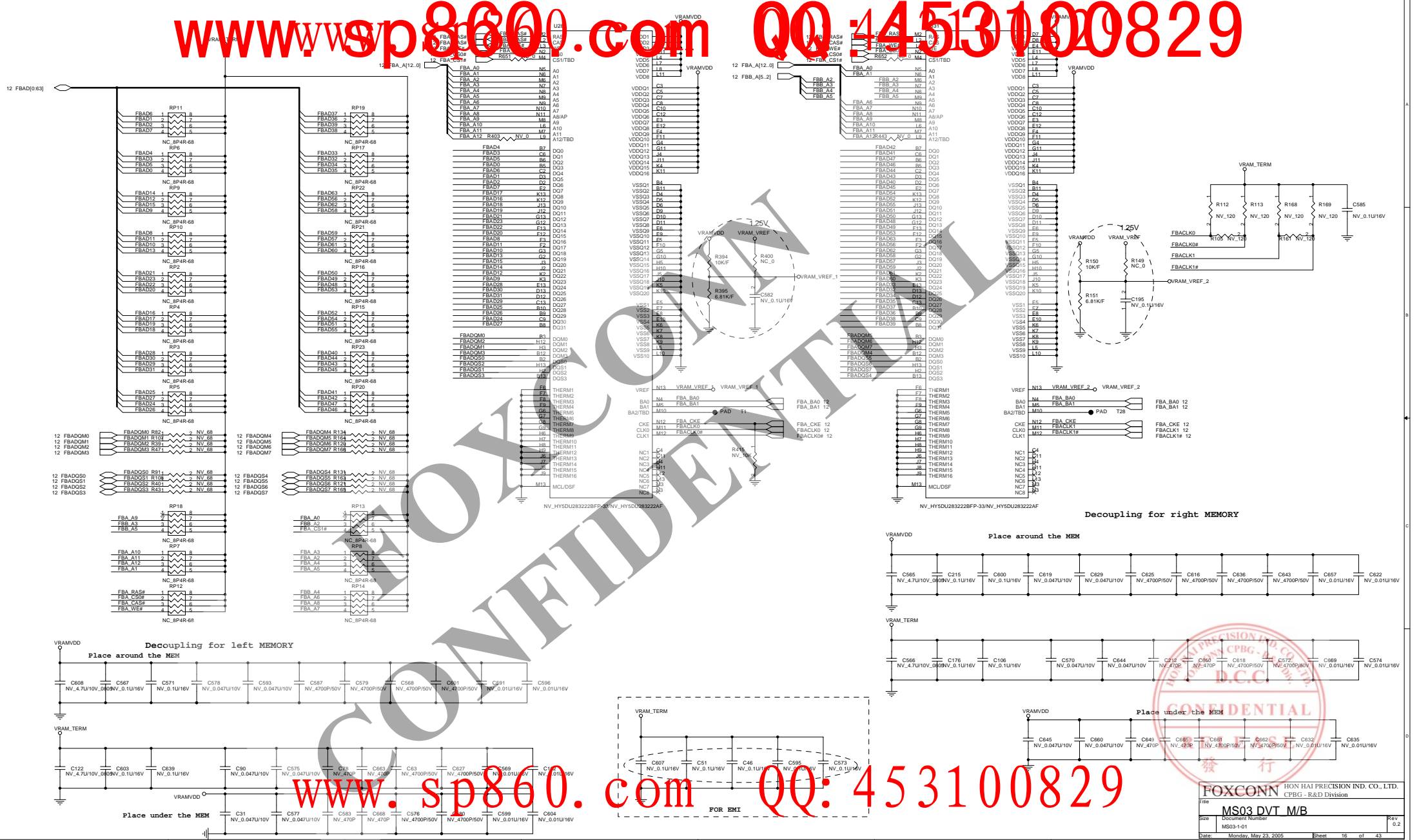
LVDS CONNECTOR

NOTEBOOK PORT REPLICATOR



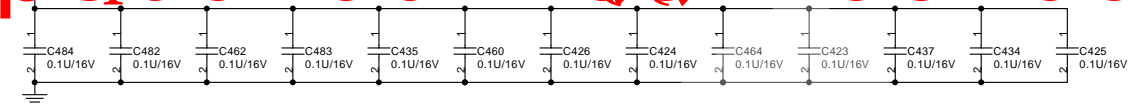
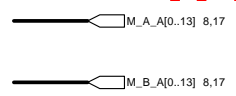
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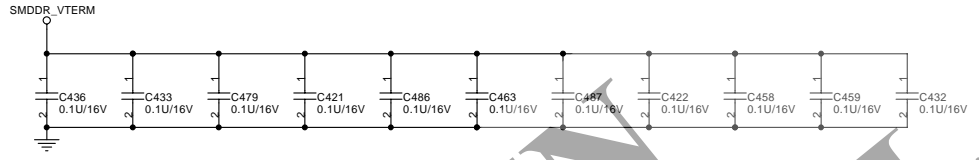




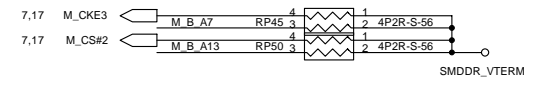
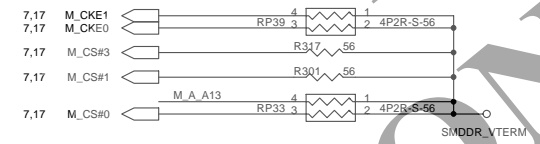
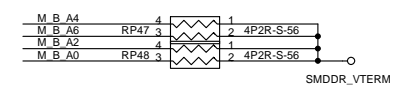
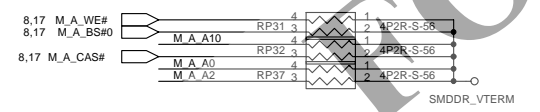
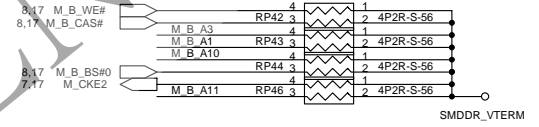
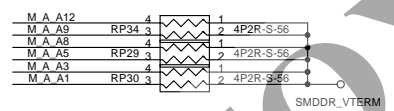
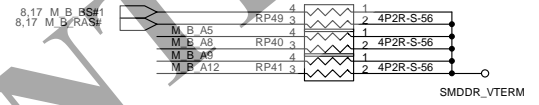
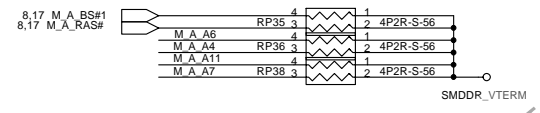




Layout note: Place 1 cap close to every 1 R-pack terminated to SMDDR\_VTERM.

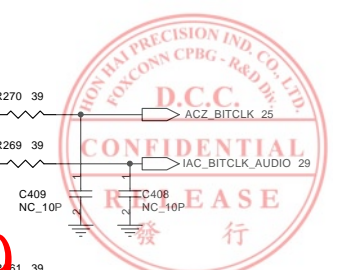
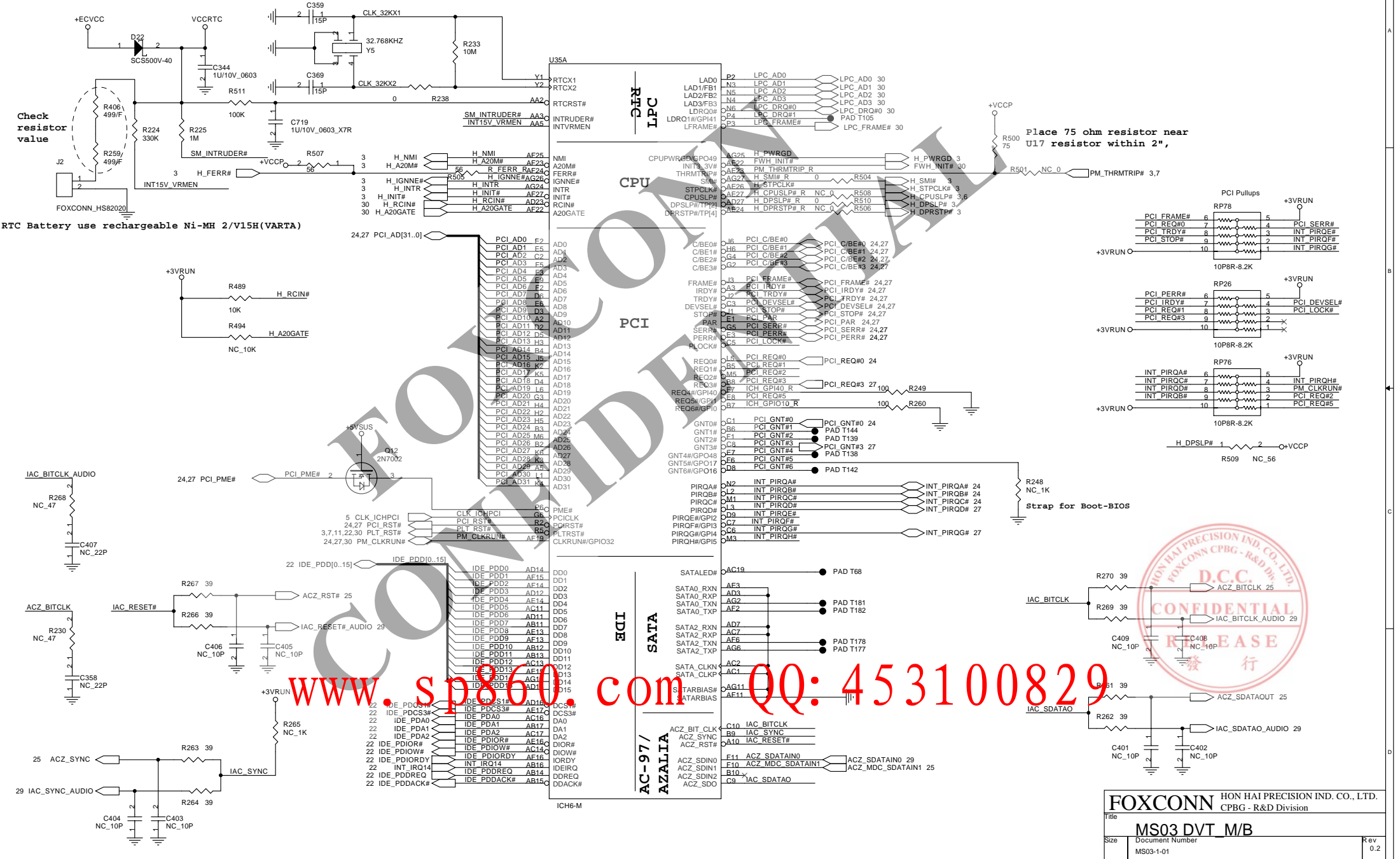


Layout note: Place 1 cap close to every 1 R-pack terminated to SMDDR\_VTERM.



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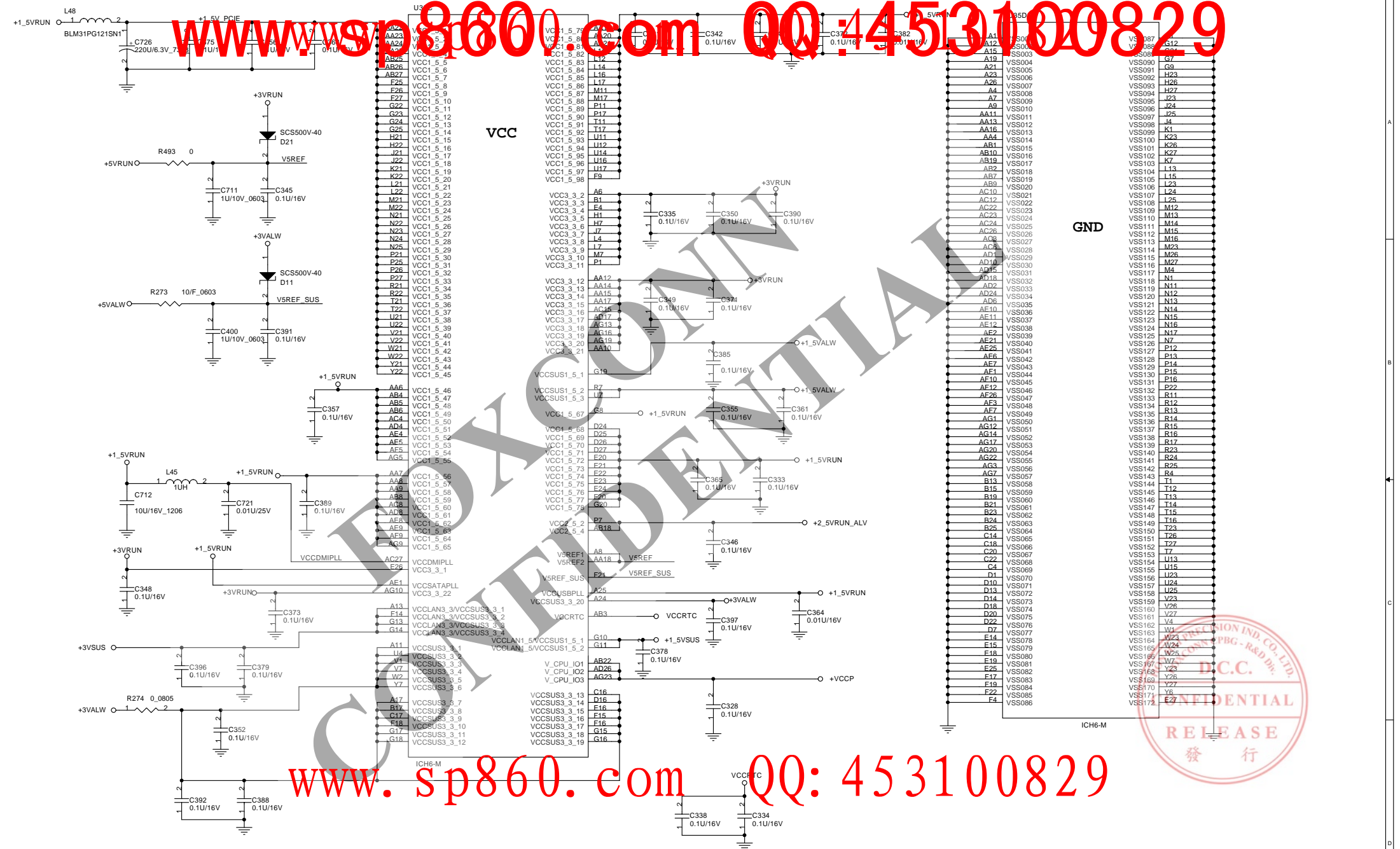






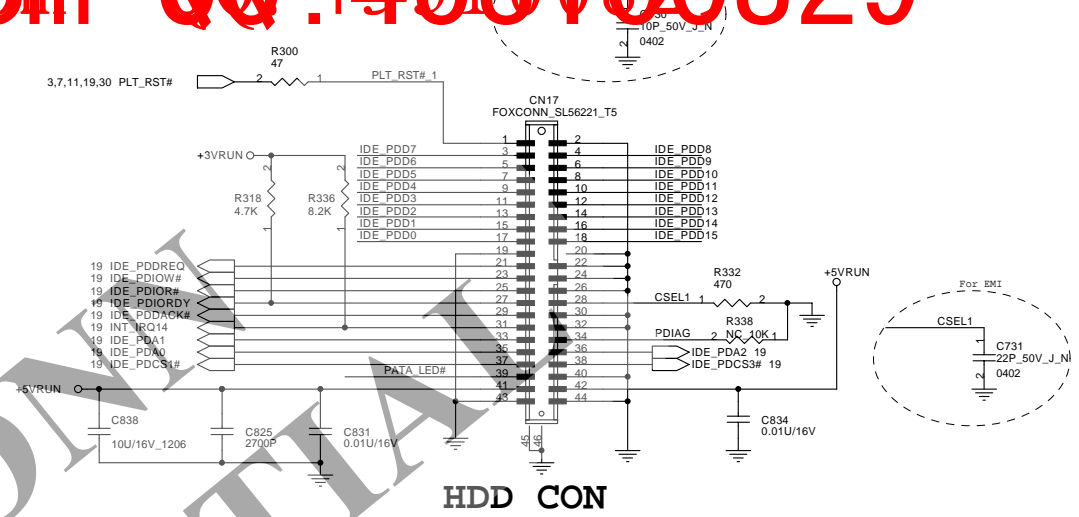


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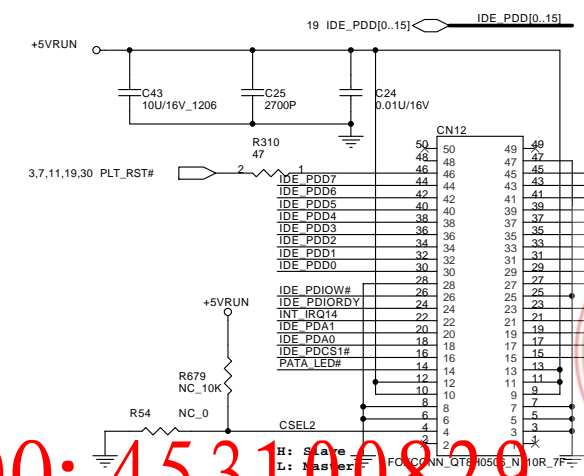


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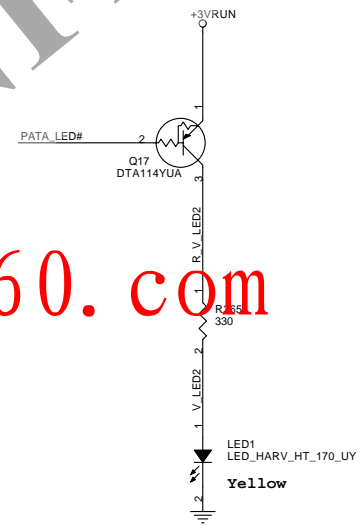




HDD CON



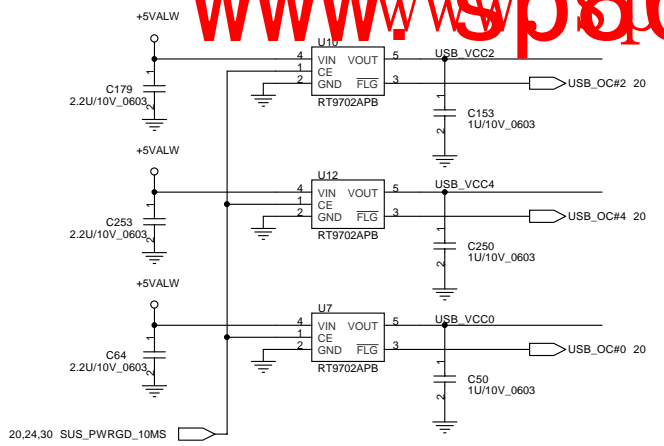
CD-ROM CON



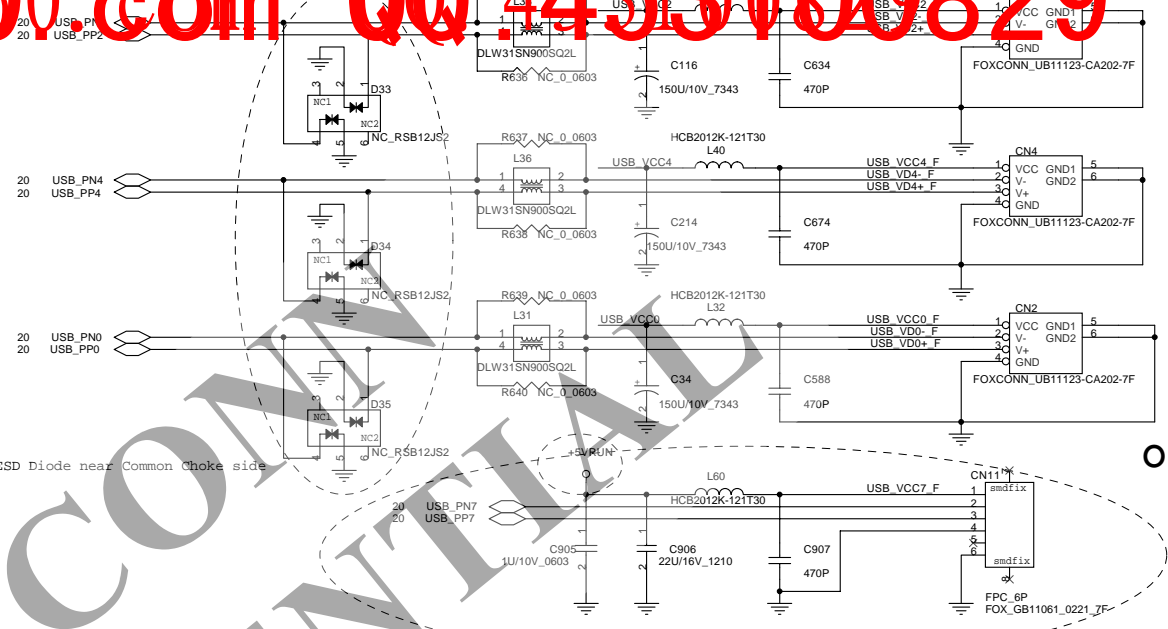
LED1  
LED\_HARV\_HT\_170\_UY  
Yellow

FOXCONN CONFIDENTIAL

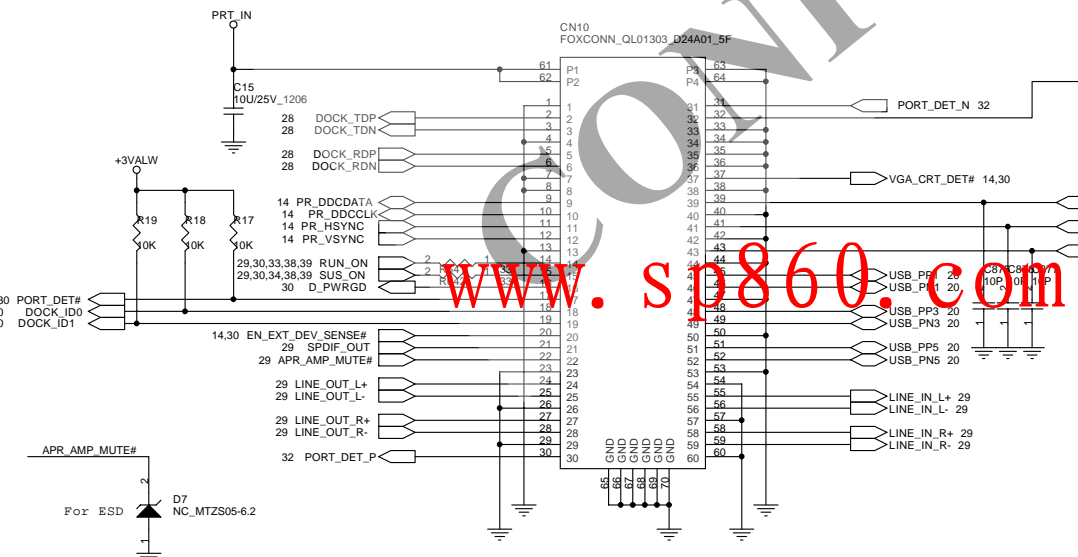
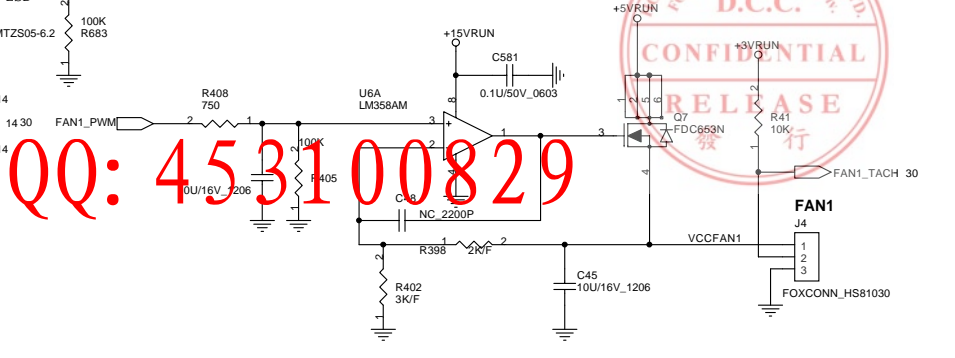
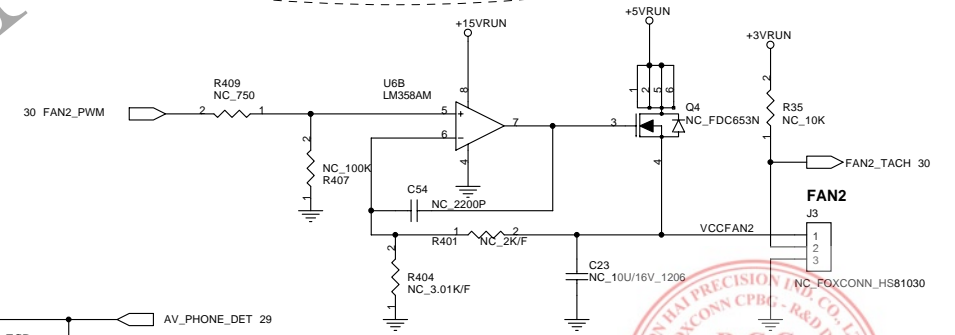
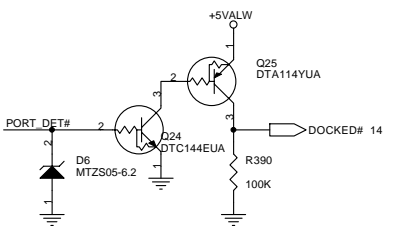




Place ESD Diode near Common Choke side



OIDE



Replicator Port

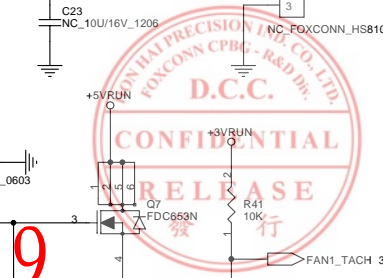
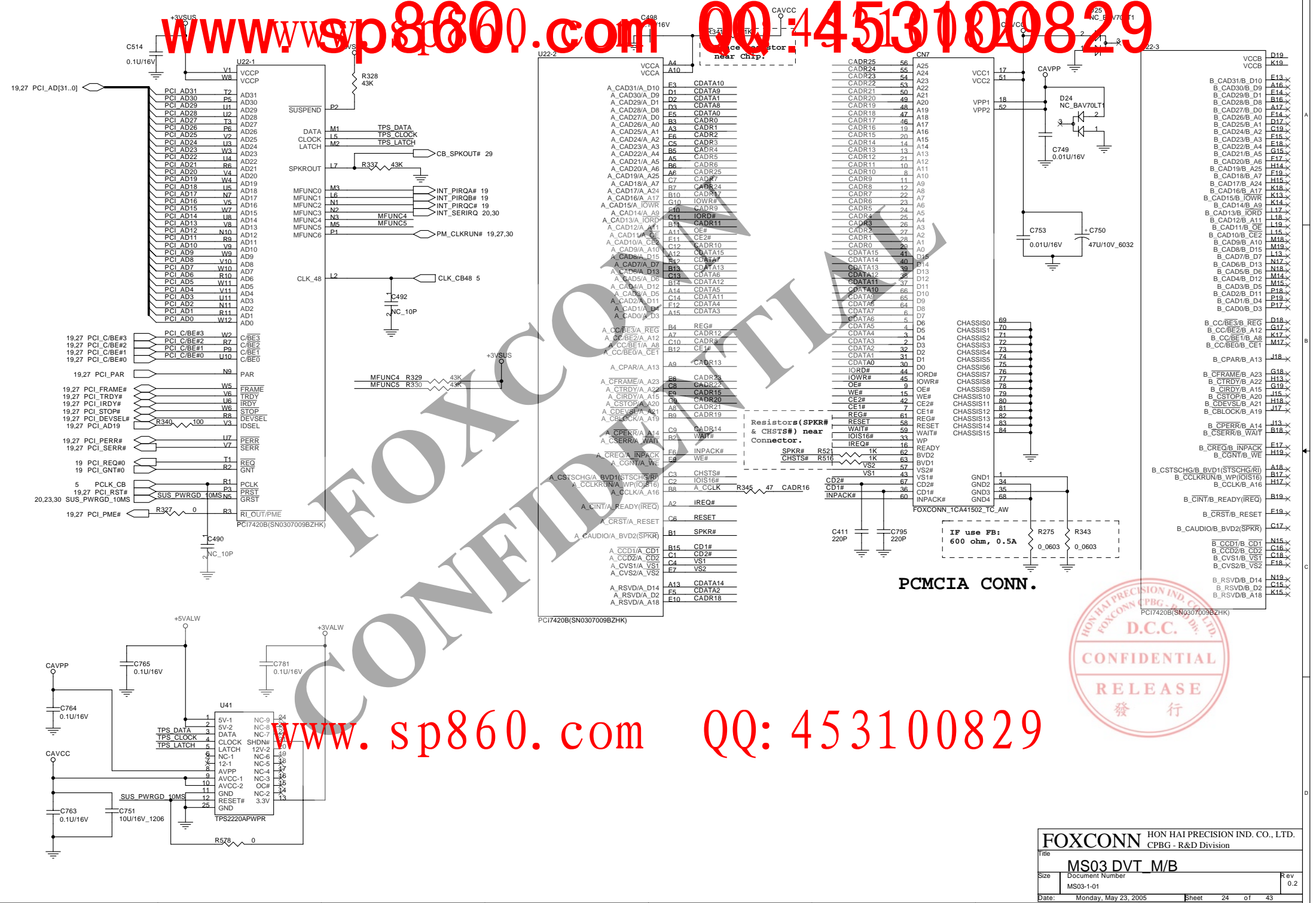


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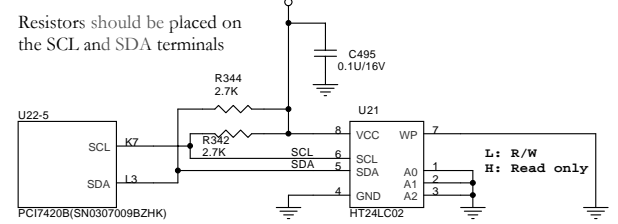
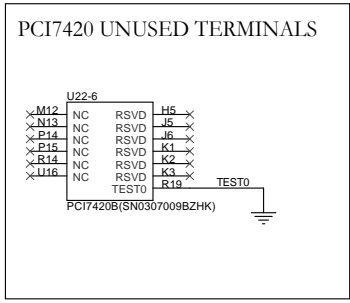
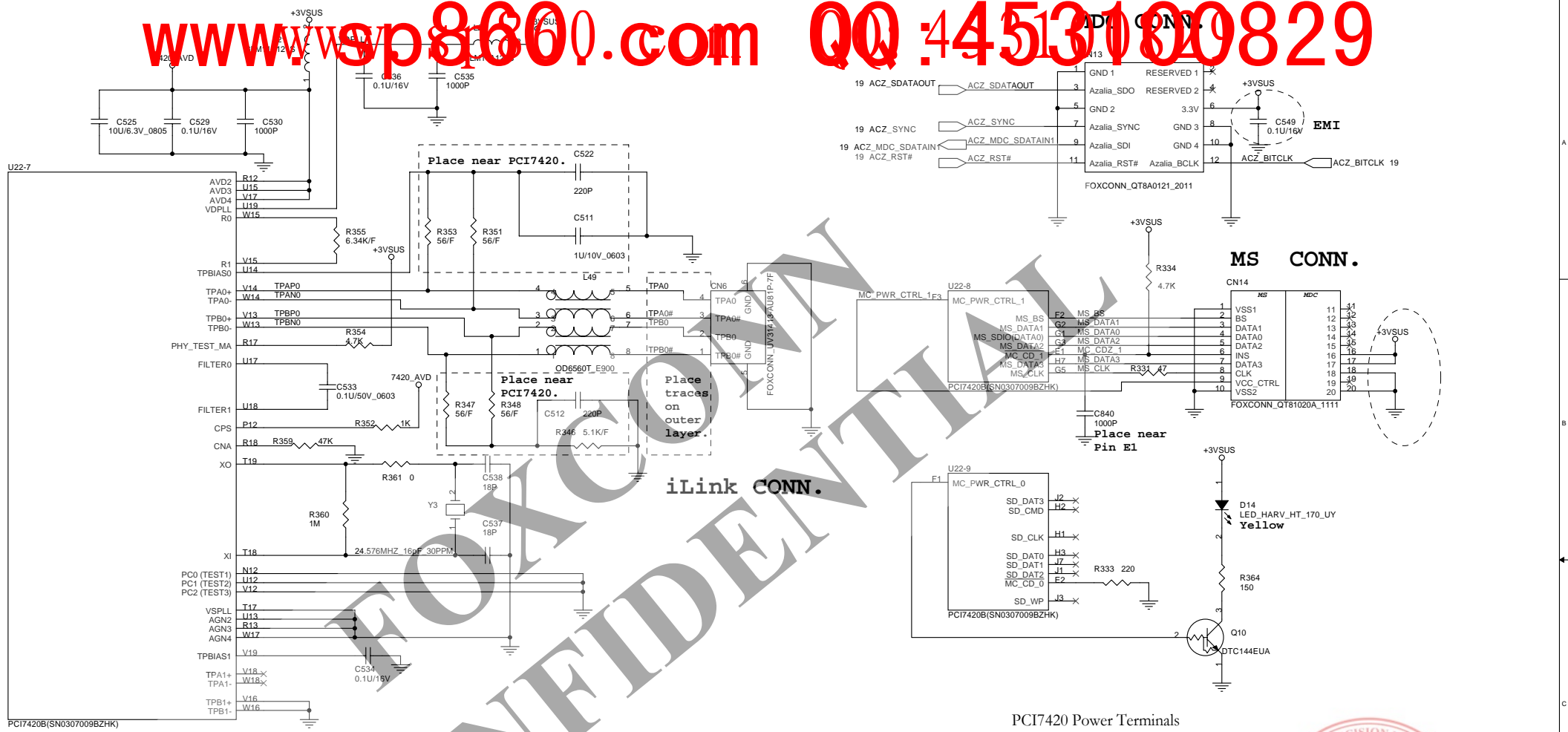
PCMCIA CONN.

IF use FB: 600 ohm, 0.5A

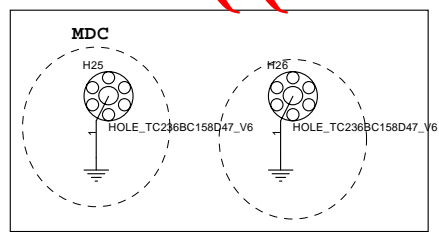
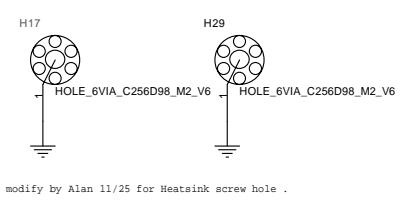
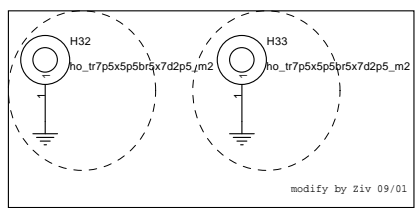
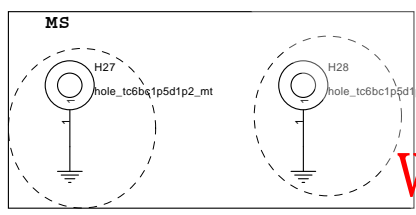
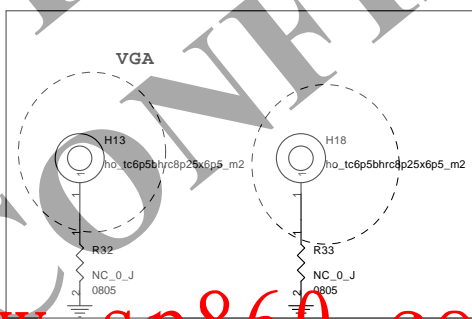
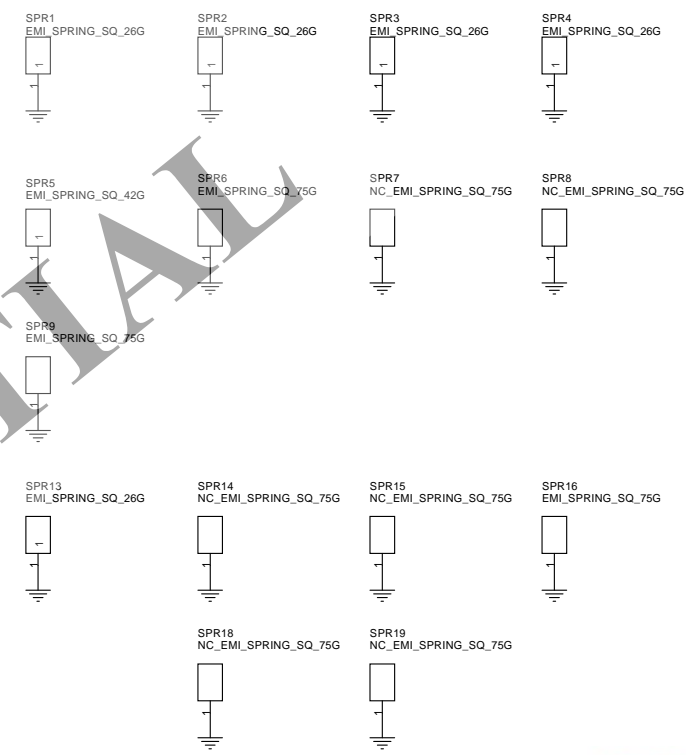
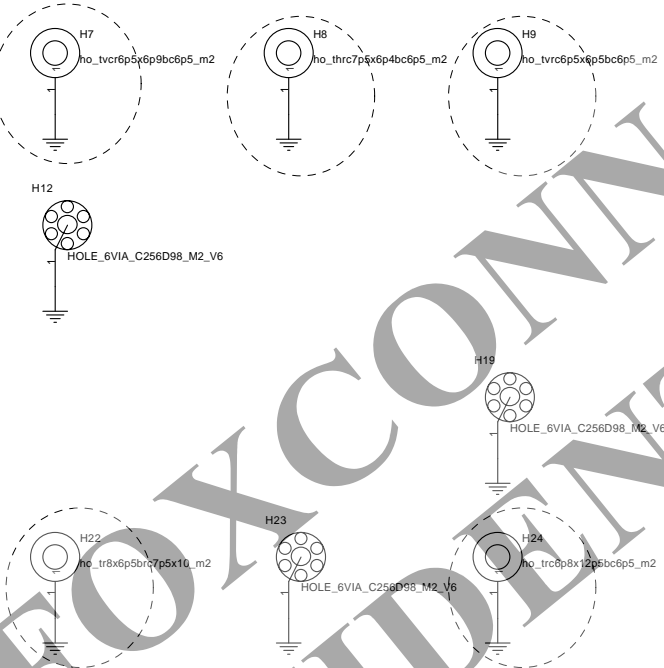
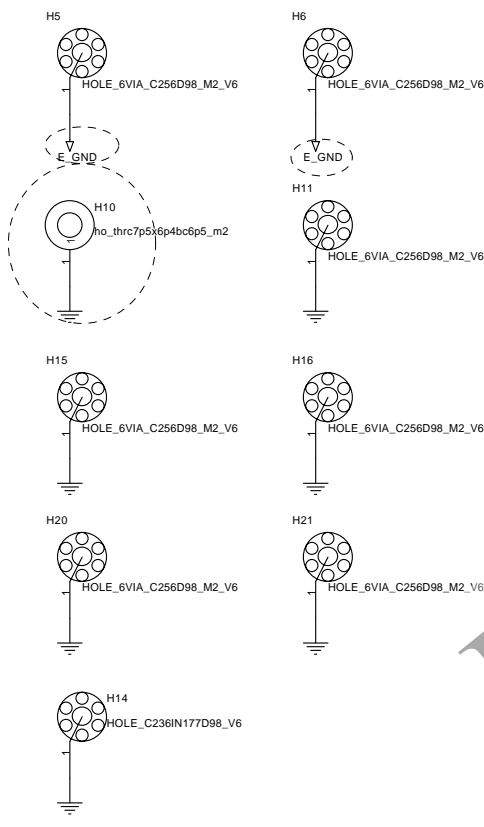
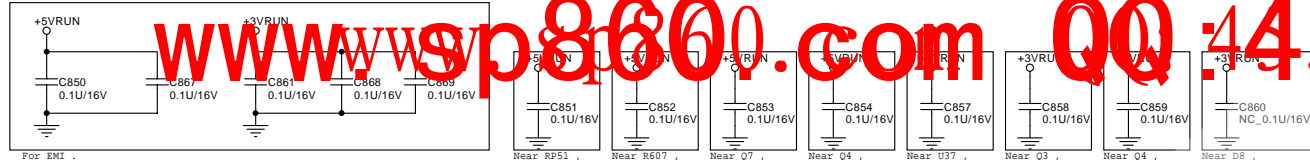
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B\_CAD30/B\_D9 E16  
B\_CAD29/B\_D8 E14  
B\_CAD28/B\_D7 E18  
B\_CAD27/B\_D0 A17  
B\_CAD26/B\_A0 B\_CAD25/B\_A1 B\_CAD24/B\_A2 B\_CAD23/B\_A3 B\_CAD22/B\_A4 B\_CAD21/B\_A5 B\_CAD20/B\_A6 B\_CAD19/B\_A25 B\_CAD18/B\_A7 B\_CAD17/B\_A24 B\_CAD16/B\_A17 B\_CAD15/B\_IOWR B\_CAD14/B\_A9 B\_CAD13/B\_IORD B\_CAD12/B\_A11 B\_CAD11/B\_OE B\_CAD10/B\_CEE B\_CAD9/B\_A10 B\_CAD8/B\_D15 B\_CAD7/B\_D7 B\_CAD6/B\_D13 B\_CAD5/B\_D6 B\_CAD4/B\_D12 B\_CAD3/B\_D5 B\_CAD2/B\_D11 B\_CAD1/B\_D4 B\_CAD0/B\_D3 B\_CC/BE3/B\_REG B\_CC/BE2/B\_A12 B\_CC/BE1/B\_A8 B\_CC/BE0/B\_CET B\_CPAR/B\_A13 B\_CFRAME/B\_A23 B\_CTRDY/B\_A22 B\_CIRDY/B\_A15 B\_CSTOP/B\_A20 B\_CDEVSL/B\_A21 B\_CBLOCK/B\_A19 B\_CPERR/B\_A14 B\_CSERR/B\_WAIT B\_CREG/B\_INPACK B\_CSNT/B\_WE B\_CSTSCHG/B\_BVD1(STSCHG/R) B\_CCLKRUN/B\_WP(IOIS16) B\_CCLK/B\_A16 B\_CINT/B\_READY(IREQ) B\_CRST/B\_RESET B\_CAUDIO/B\_BVD2(SPKR) B\_CCD1/B\_CDI1 B\_CCD2/B\_CDI2 B\_CVS1/B\_VS1 B\_CVS2/B\_VS2 B\_RSVD/B\_D14 B\_RSVD/B\_D2 B\_RSVD/B\_A18







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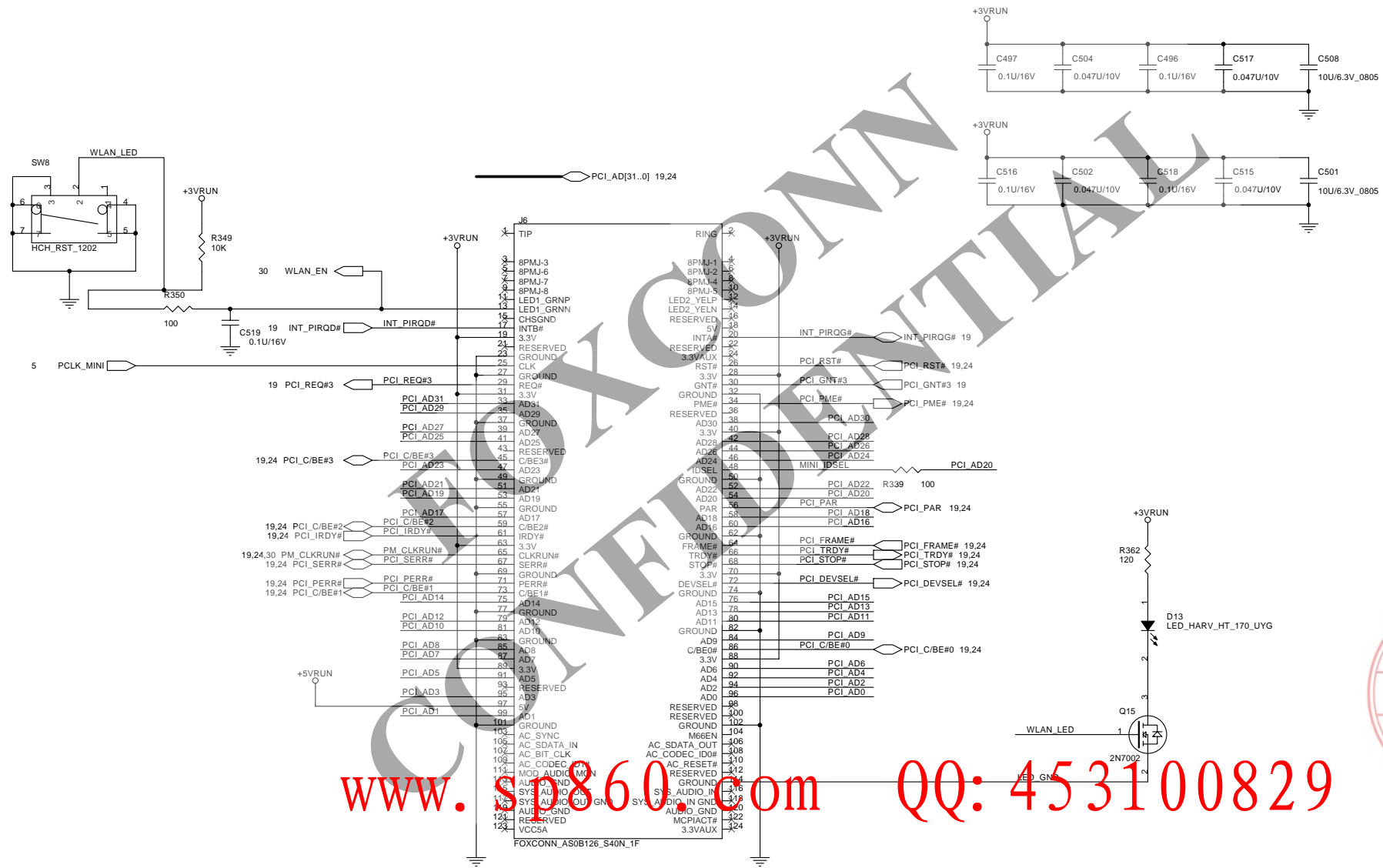
www.sp860.com QQ: 453100829



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modify by Ziv 09/01

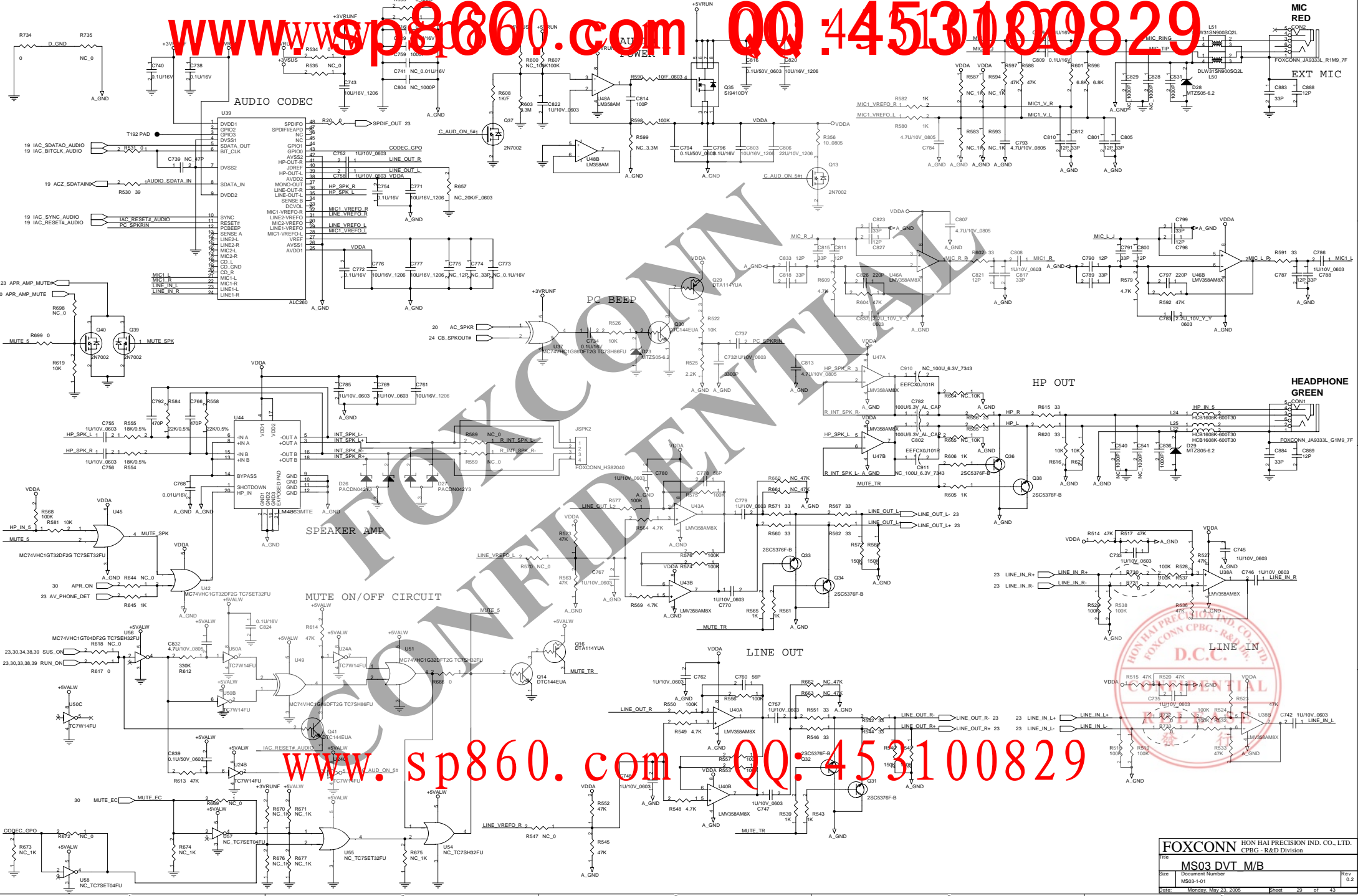
modify by Alan 11/25 for Heatsink screw hole .



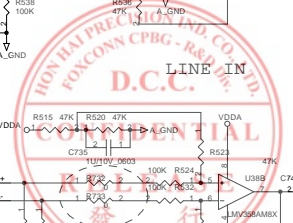




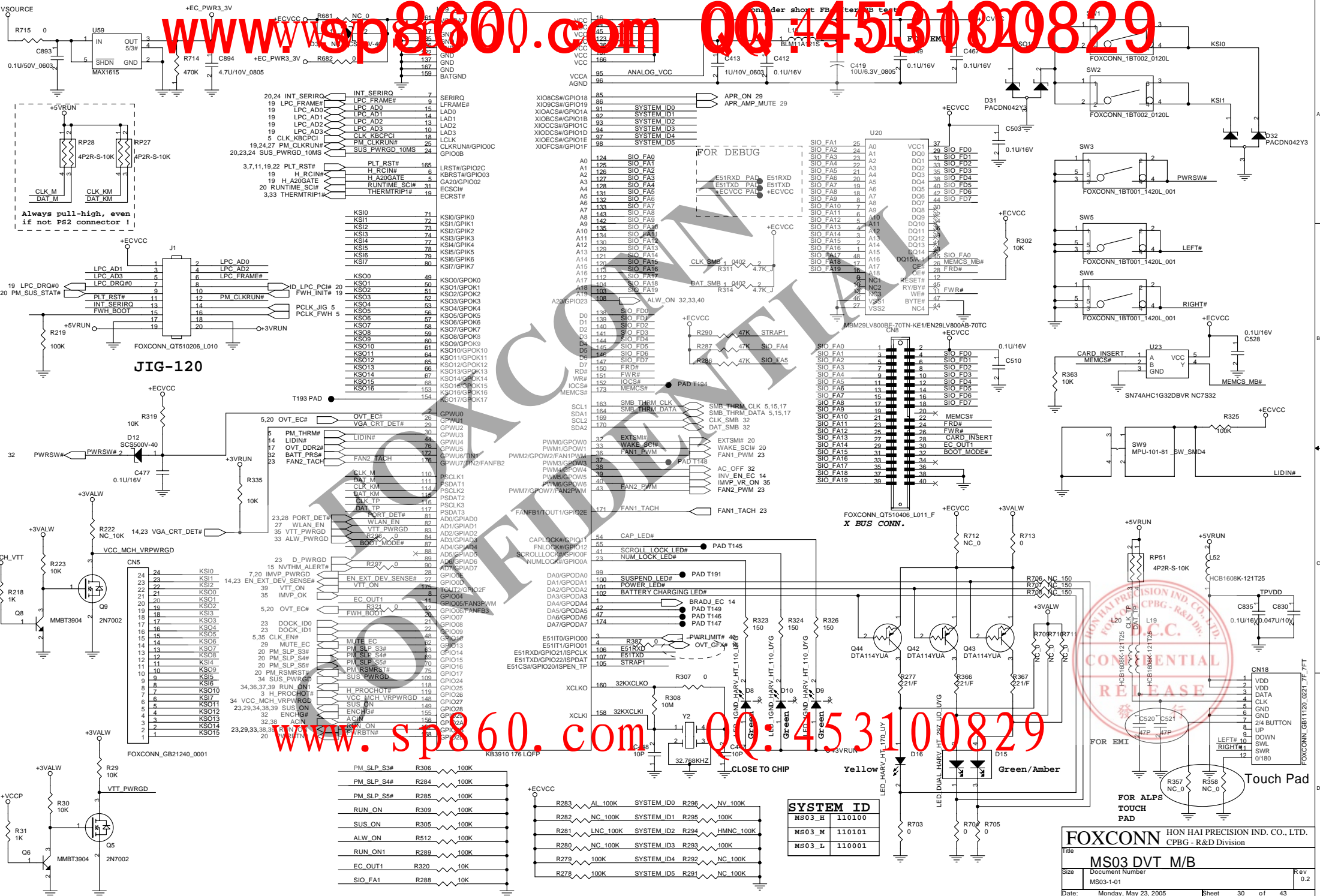
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Always pull-down, even if not PS2 connector!

JIG-120

FOR DEBUG

X BUS CONN.

SYSTEM ID	
MS03_H	110100
MS03_M	110101
MS03_I	110001

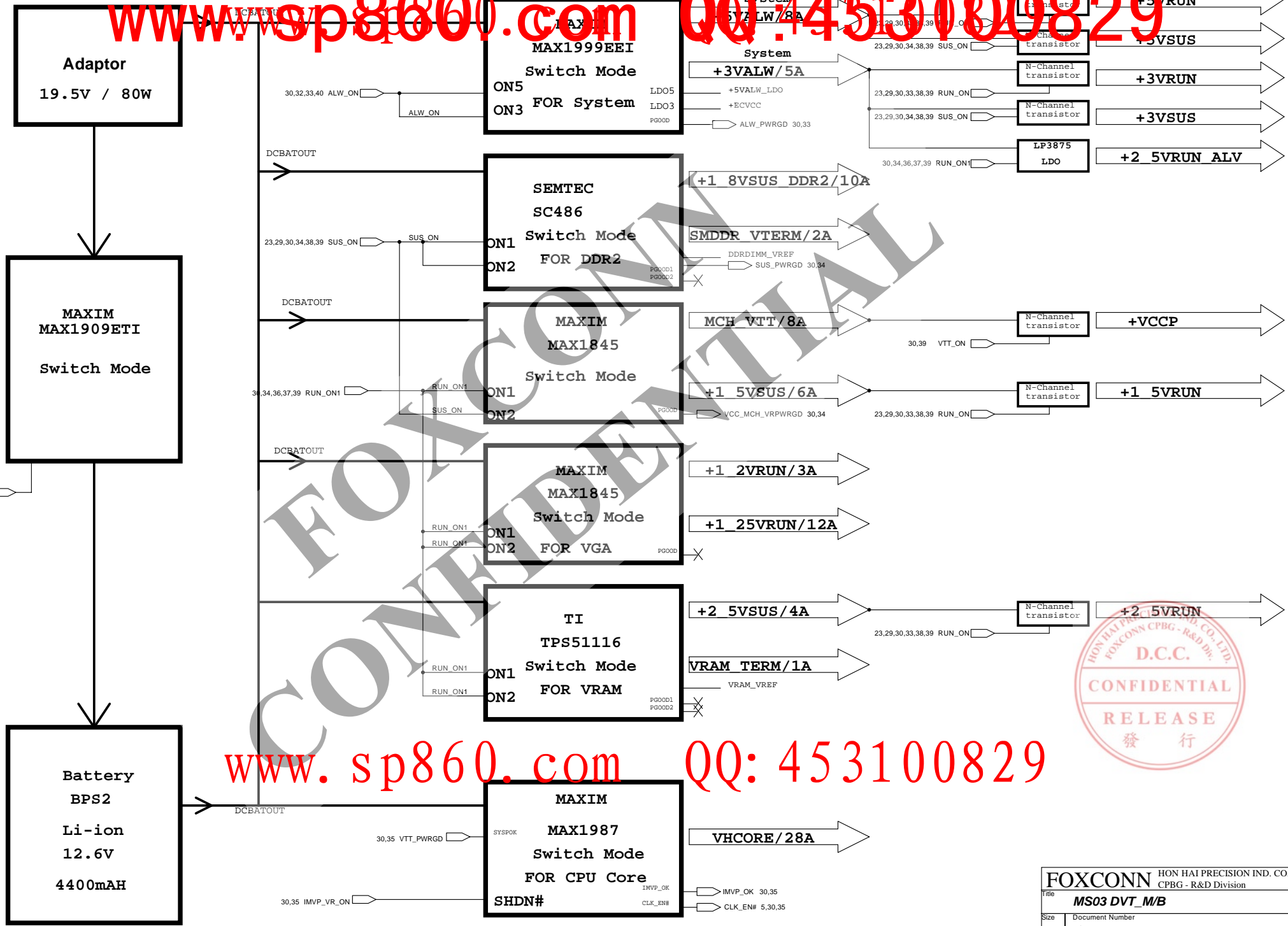
PM_SLP_S3#	R306	100K
PM_SLP_S4#	R284	100K
PM_SLP_S5#	R285	100K
RUN_ON	R309	100K
SUS_ON	R305	100K
ALW_ON	R512	100K
RUN_ON1	R289	100K
EC_OUT1	R320	10K
SIO_FA1	R288	10K

R283	AL	100K	SYSTEM_ID0	R296	NV	100K
R282	NC	100K	SYSTEM_ID1	R295	NC	100K
R281	LNC	100K	SYSTEM_ID2	R294	HMNC	100K
R280	NC	100K	SYSTEM_ID3	R293	NC	100K
R279	100K		SYSTEM_ID4	R292	NC	100K
R278	100K		SYSTEM_ID5	R291	NC	100K

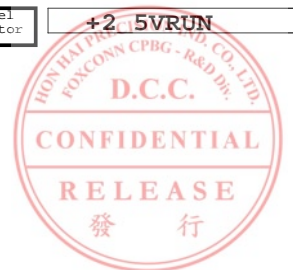
FOXCONN HON HAI PRECISION IND. CO., LTD. CPBG - R&D Division

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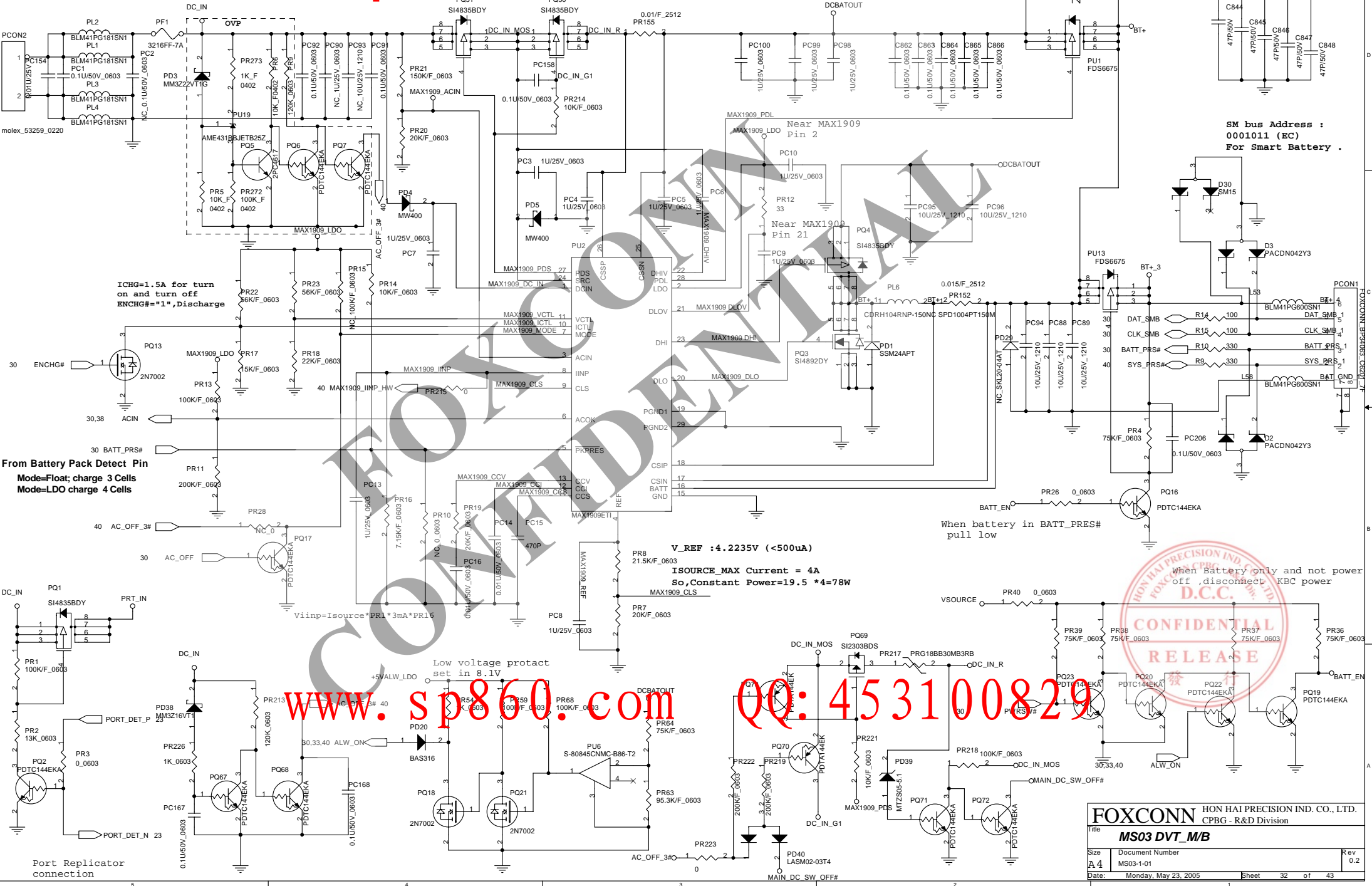
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ICHG=1.5A for turn on and turn off  
ENCHG="#1", Discharge

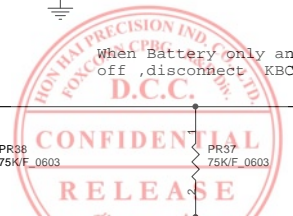
From Battery Pack Detect Pin  
Mode=Float; charge 3 Cells  
Mode=LDO charge 4 Cells

V\_REF : 4.2235V (<500ua)  
ISOURCE\_MAX Current = 4A  
So, Constant Power=19.5 \*4=78W

Low voltage protect set in 8.1v

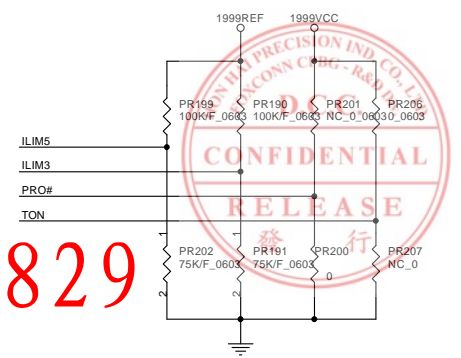
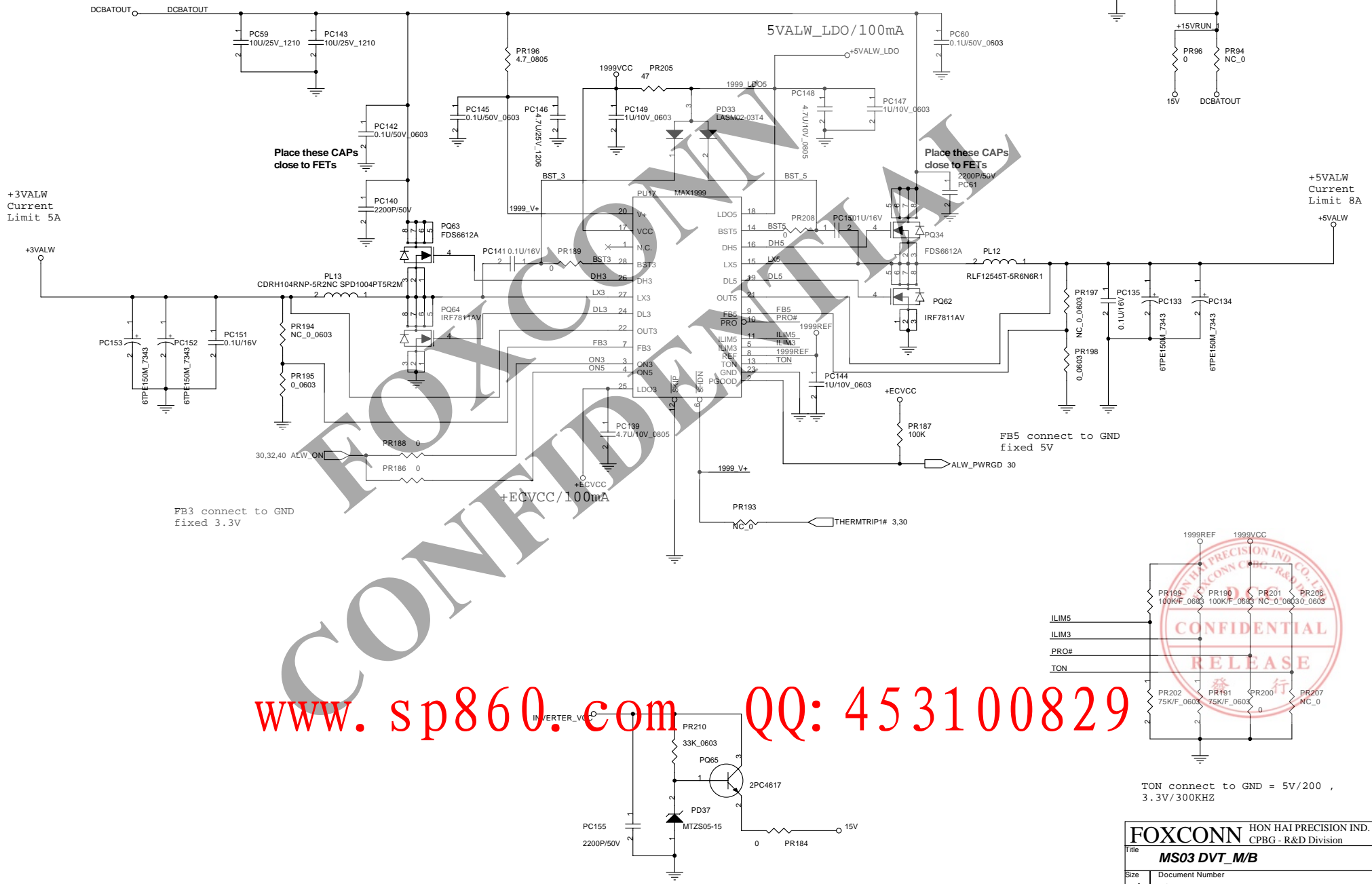
When battery in BATT\_PRES# pull low

When Battery only and not power off, disconnect KBC power



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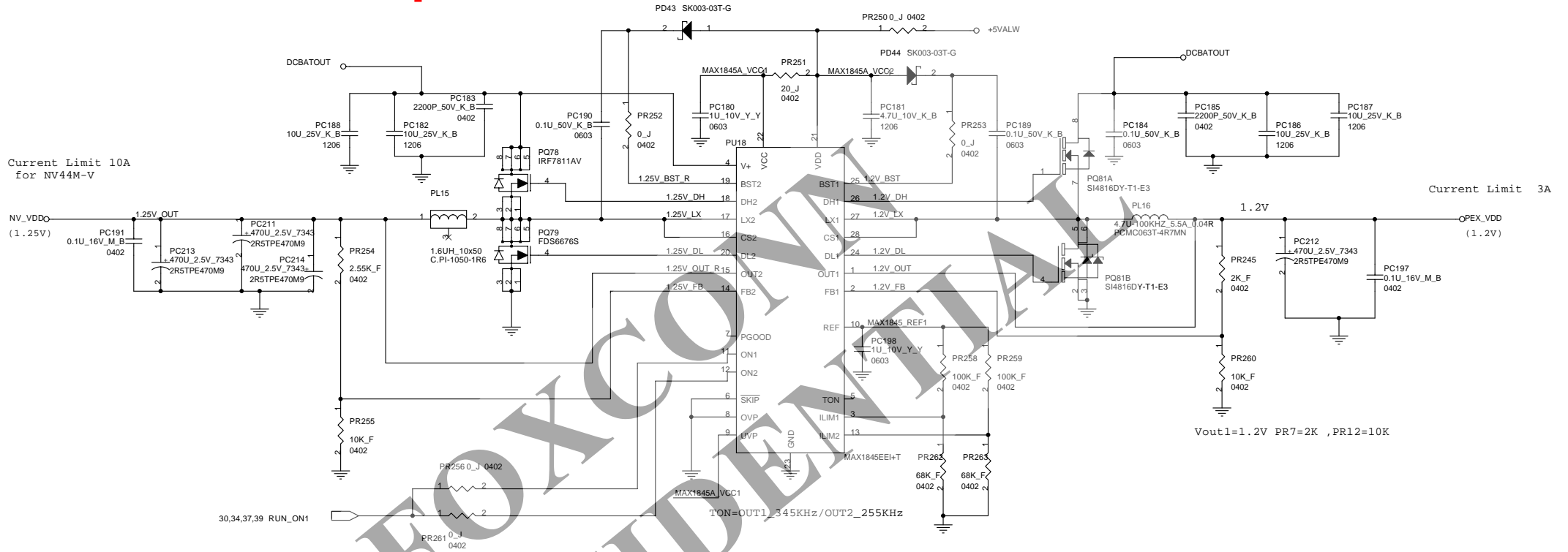




TON connect to GND = 5V/200, 3.3V/300KHZ



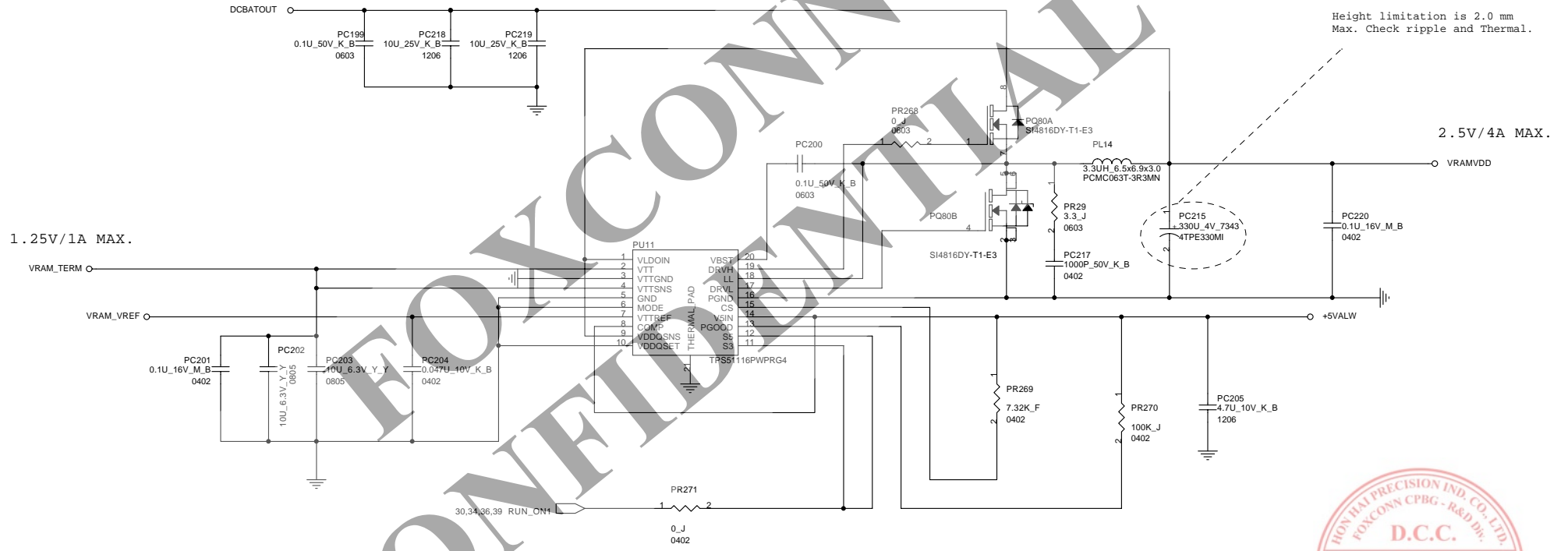




Power daughter board for VGA

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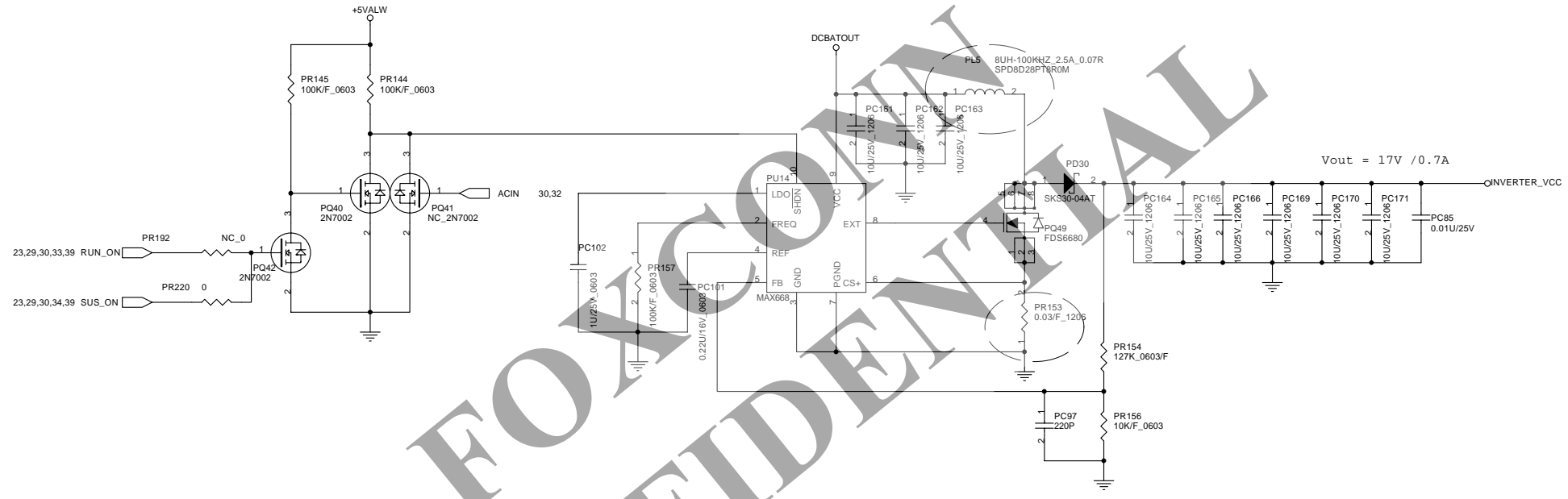


Height limitation is 2.0 mm  
Max. Check ripple and Thermal.



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Change PL5 and PR153 for improving the step-up circuit

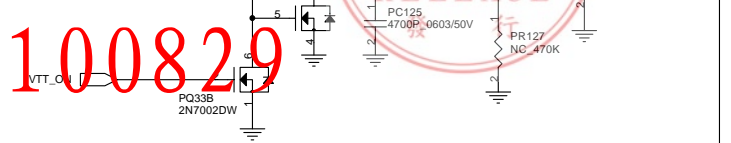
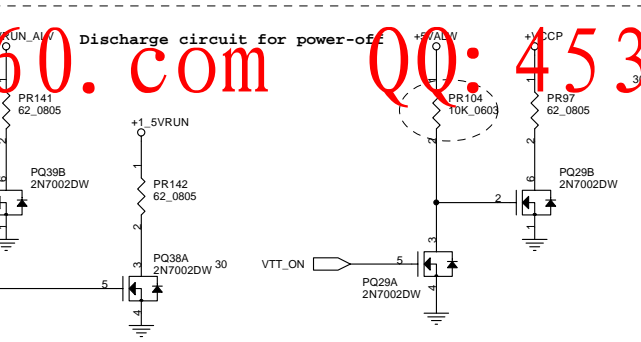
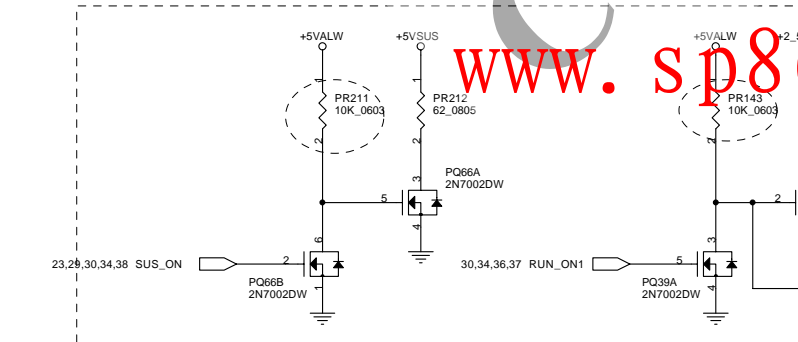
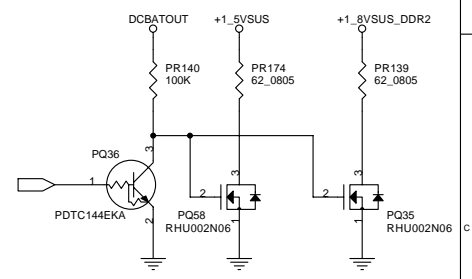
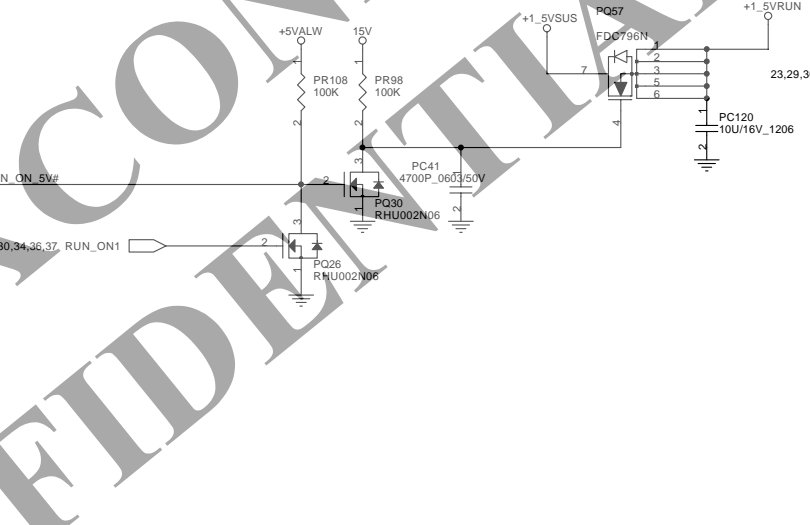
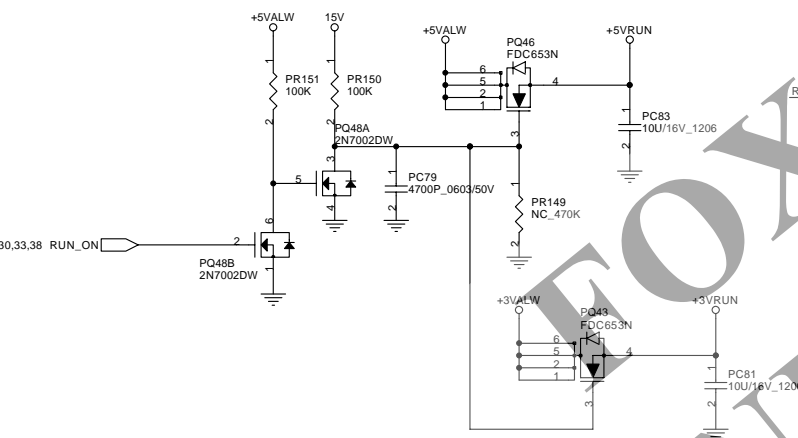
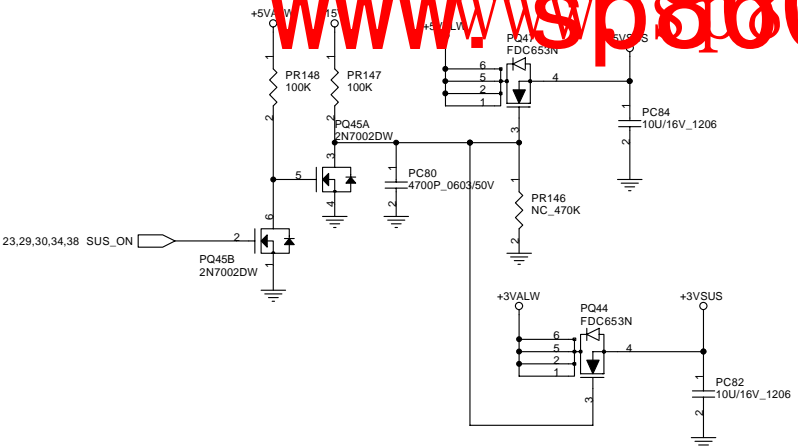
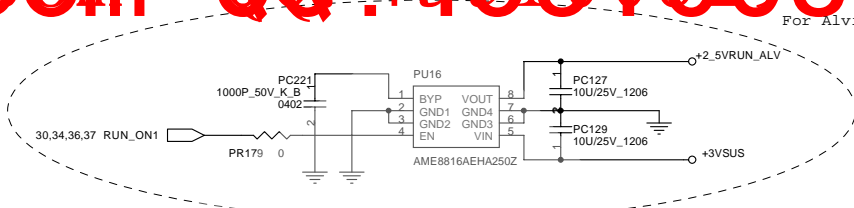


FOAM CONFIDENTIAL

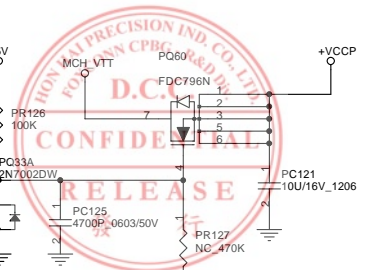


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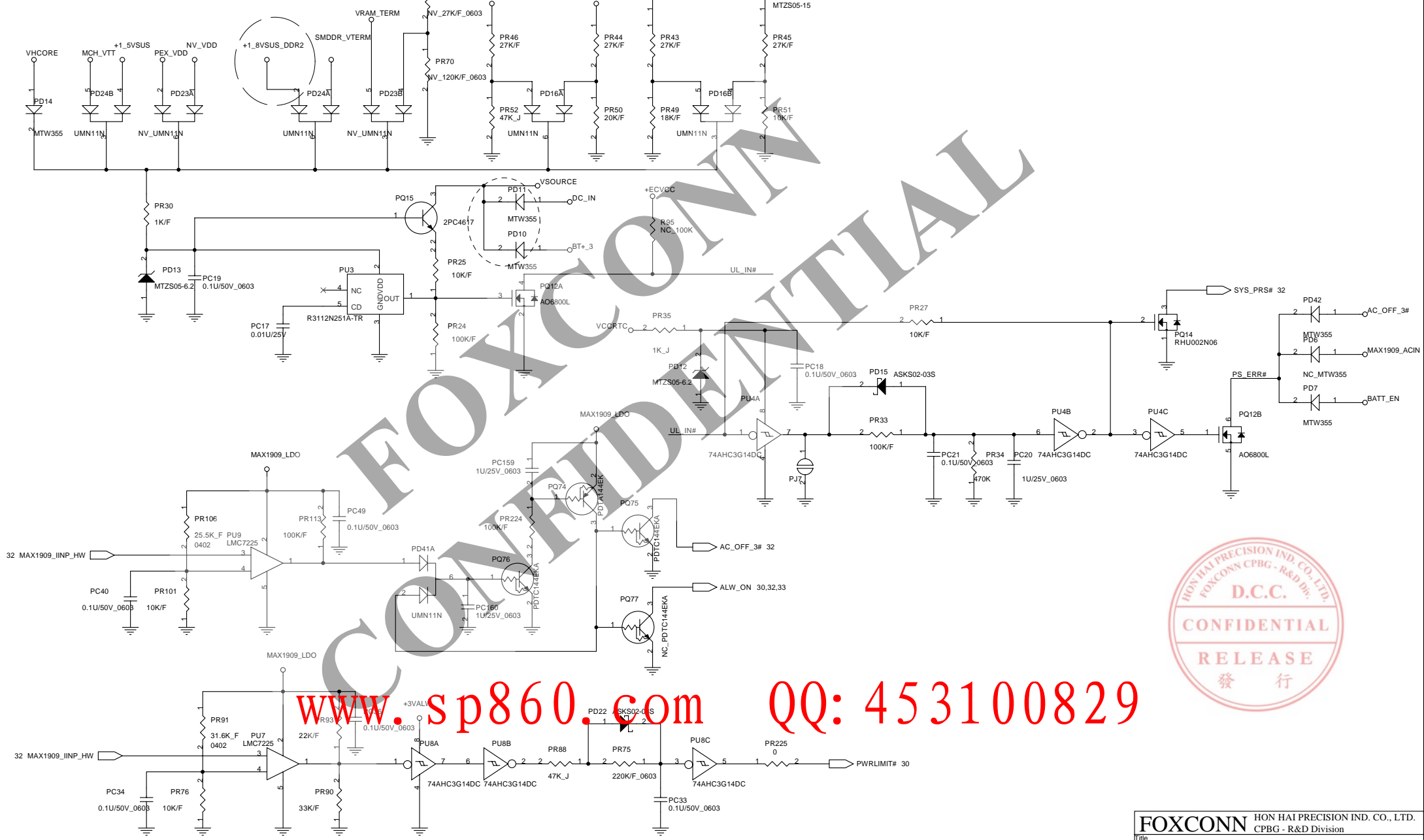


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Title <b>MS03 DVT_M/B</b>		
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Change net name to +1\_8VSUS\_DDR2 and delete PR89,PR92



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**HISTORY**

**EVT board start**

(2005/03/31)  
P14: Change D1 from NC to mount.  
P15: Change R115 from mount to NC.

(2005/04/01)  
P40: Rotate PD10, PD11.

(2005/04/12)  
P14: Correct LVDS Bus relative of connection ( swap Data+/Data-, CLK+/CLK- ).  
P25: Change CN14 pin16, pin17 from NC to +3VSUS, change CN14 pin18, pin20 from NC to GND.  
P30: Delete SW7, Q46, R396, R721.

(2005/04/25)  
P12: Add T195 for measure VRAM Timing.

(2005/04/26)  
P14: Delete the right side dot of L1.

(2005/04/29)  
P14: Change Q22, Q23 from 2N7002 to BSS138.

(2005/05/04)  
P14: Change R694, R695, R696, R697 from 2.2K to 0 ohm.

(2005/05/09)  
P26: Change H14 part from HOLE\_6VIA\_C256IN177D98\_M2\_V6(6.5mm) to HOLE\_C236IN177D98\_V6(6.0mm).  
P15: Change R701 from NC to mount, change R702 from mount to NC.

(2005/05/10)  
P32: Change PD3 from P4SSMJ24APT to MM3Z22VT1G.  
P32: Change PQ5 from PDDTC144EKA to 2PC4617.  
P32: Change PR5 from 75K/F\_0603 to 10K/F\_0402.  
P32: Change PR6 from 120K\_0603 to 10K/F\_0402.  
P32: Add PU19 AME, AME431BBJETB25Z.  
P32: Add PR272 100K/F\_0402.  
P32: Add PR273 1K/F\_0402.  
P36: Change PR262 from 15.8K/F\_0402 to 68K/F\_0402.  
P36: Change PR263 from 40.2K/F\_0402 to 68K/F\_0402.  
P36: Change PL15 footprint from CHOKE\_3P\_348\_409X409\_2 to CHOKE\_3P\_315\_394X394\_2.  
P36: Delete PJ11, PJ12.  
P37: Delete PJ13, PJ14.  
P39: Delete PJ8, PR178.  
P39: Add PC221 1000P\_50V\_0402.

P39: Change PU16 from LP3875 to AME8816AEHA250Z.  
P05: Change R478, R481 from 33ohm to 56ohm for rising edge rate and falling edge rate.  
P05: Change C696, C698, C700, C701, C702, C706 from NC to 18pF (EMI solution).  
P22: Add C730, C731 (EMI solution).  
P22: Connect CN17.20, CN17.32, CN17.44 to GND.  
P26: Change SPR7, SPR15 from mount to NC (EMI solution).

(2005/05/11)  
P23: Add D33,D34 and D35 for ESD(Not mount).  
P36: Change PL15 footprint from CHOKE\_3P\_348\_409X409\_2 to L\_3P\_315\_394X394.

(2005/05/13)  
P26: Change H25, H26 footprint from ho\_tc236bc158d7v6 to ho\_tc236bc158d17.  
P26: Change H27, H28 footprint from ho\_tclp5bc1p2 to ho\_tclp5bc1d12.

(2005/05/16)  
P02: Update symbol ahead table, add LNC\_ and HMNC\_.  
P30: Change R280 from mount to NC.  
P30: Change R281 from AL\_100K to LNC\_100K.  
P30: Change R293 from NC to mount.  
P30: Change R294 from NV\_100K to HMNC\_100K.

(2005/05/17)  
P26: Add R32, R33 NC\_0\_J (EMI solution).

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**HISTORY**

(2005/05/18)

- P29: Change C783, C837 from 100V\_6 to 220V\_4
- P26: Change H27, H28 from ho\_tc1p5bc6d1p2\_mt(ho\_tc1p5bc6d1p2\_mt) to hole\_tc6bc1p5d1p2\_mt(ho\_tc6bc1p5d1p2\_mt).
- P40: Change PR91 from 31.6K to 25.5K, change PR109 from 49.9K to 31.6K.
- P29: Delete R611, R622, R628, R629, R647, R648, R649, R650, JSPK1.
- P29: Add C910, C911 NC\_100U\_6.3V\_7343.

(2005/05/19)

- P29: Add R734,R735 for anti-digital noise interference.

(2005/05/20)

- P30: Change R311, R314 from 10K to 4.7K\_J.
- P29: Change R735 from mount to NC.
- P05: Change R481 from 56ohm to 47ohm.
- P05: Change R478 from 56ohm to 47ohm.

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